

X-ray monochromators

T. Matsushita

Photon Factory

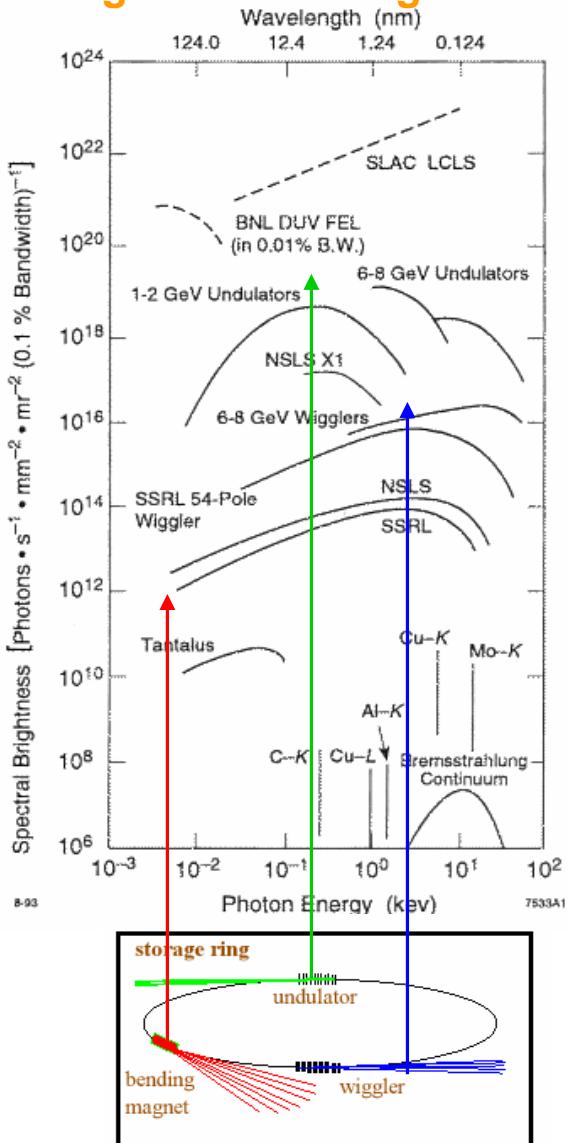
High Energy Accelerator Research Organization

outline

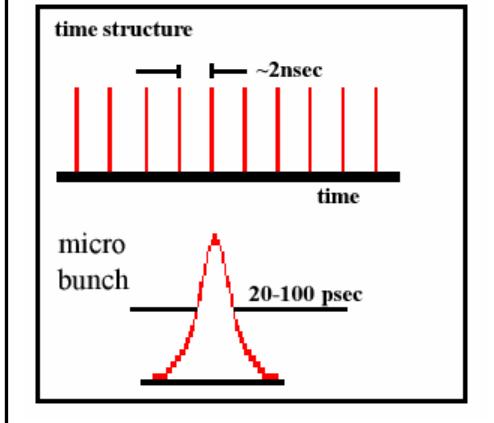
1. Controlling X-ray beam properties and the roll of crystal monochromators
2. Bragg diffraction by crystals
3. Dynamical diffraction
4. Double crystal monochromator
5. Heat load and cooling
6. Higher harmonics rejection
7. High resolution monochromators
8. Phase retarder and polarization conversion
9. Curved crystals
10. Other issues and future problems

Synchrotron Radiation - Basic Properties

High flux and brightness



Pulsed time structure



Broad spectral range

Polarized (linear, elliptical, circular)

Small source size

Partial coherence

High stability

HIGH VACUUM ENVIRONMENT

$$\text{Flux} = \frac{\# \text{ of photons in given } \Delta\lambda/\lambda}{\text{sec, mrad } \theta}$$

Brightness (Brilliance)

$$= \frac{\# \text{ of photons in given } \Delta\lambda/\lambda}{\text{sec, mrad } \theta, \text{ mrad } \varphi, \text{ mm}^2}$$

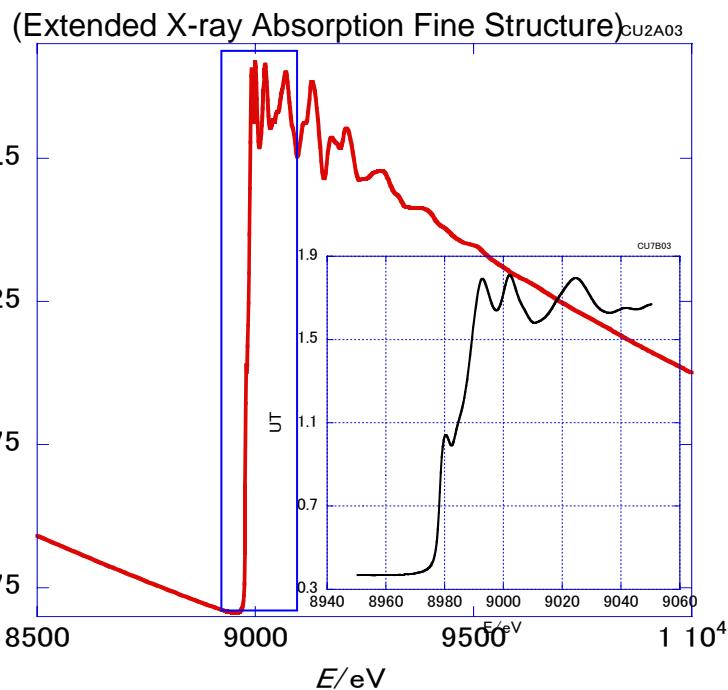
(a measure of concentration of the radiation)

Designing your experiment

- X-ray optical consideration -

— UT

EXAFS

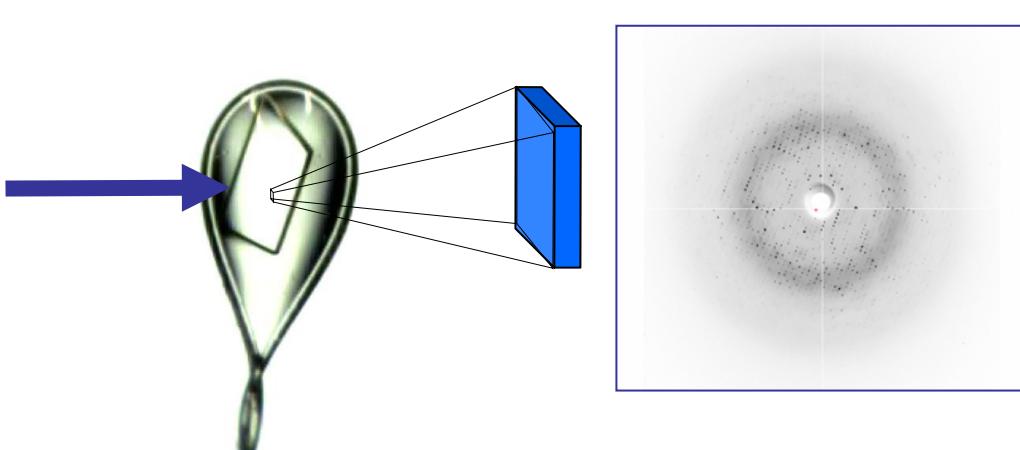


E : ~4 keV - ~20 keV (~10 keV - ~50 keV)

$\Delta E/E$: ~10⁻⁴

Beam size: 1 mm x 10 mm – 1 μm^2

Protein crystallography



λ : 0.7 Å ~ 3 Å (E : 18 keV ~4 keV)

$\Delta\lambda/\lambda$ ($\Delta E/E$) : 10⁻³ ~10⁻⁴

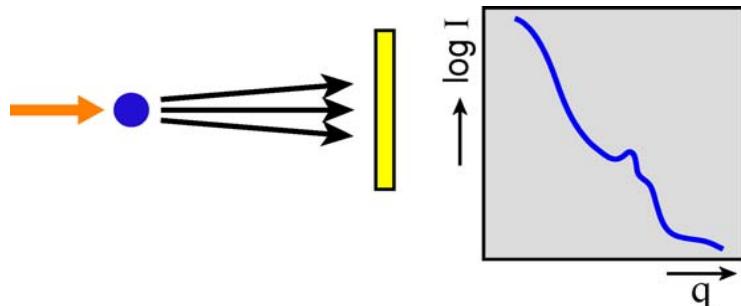
Angular divergence : 2 ~ 0.2 mrad

Beam spot size : 5 ~ 200 μm

Designing your experiment

- X-ray optical consideration -

Small angle scattering



PF 15A (bending magnet)

E: 6keV- 20 keV

$\Delta E/E: 10^{-3}$

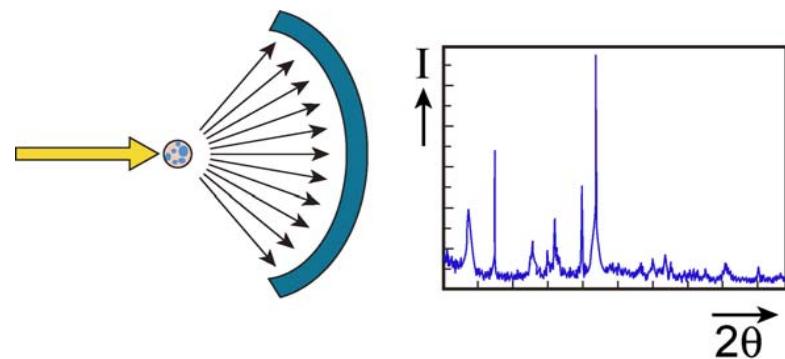
Angular convergence:

0.1- 0.2 mrad (V)
1- 2 mrad (H)

Focal spot size:

0.3 mm (V) - 1.0 mm (H)

Powder diffraction



Spring-8 BL02B (bending magnet)

E: 10 keV – 35 keV

$\Delta E/E: \sim 10^{-4}$

Angular divergence:

0.5 – 1 mrad

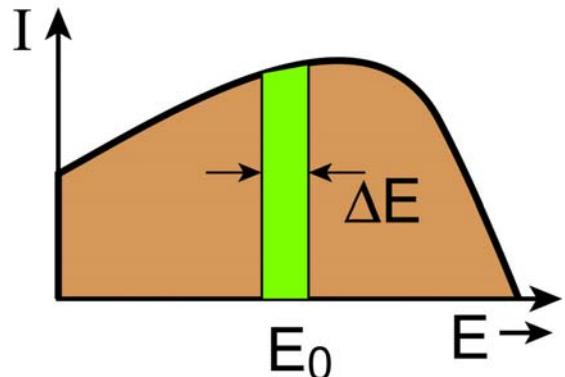
Beam size:

V: 0.1 ~ 0.5 mm

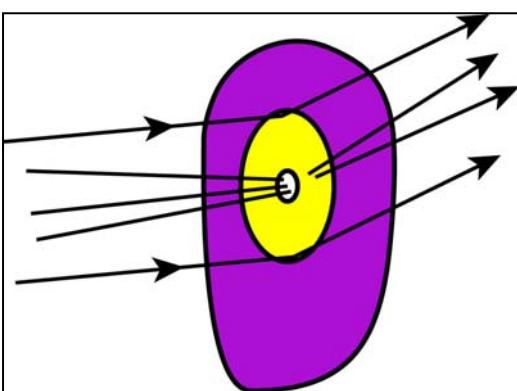
H: 1 ~ 3 mm

Controlling the X-ray beam properties by X-ray crystal monochromators

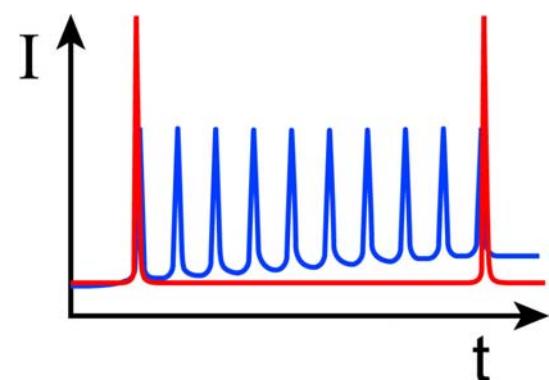
Energy, energy resolution



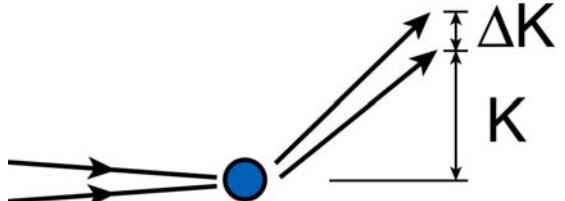
Spatial spread



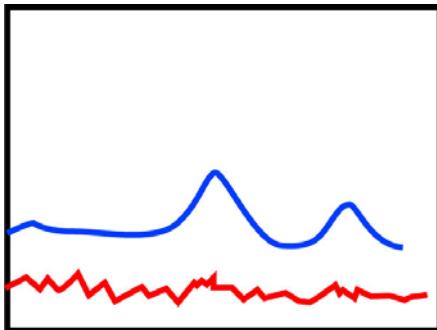
Time structure



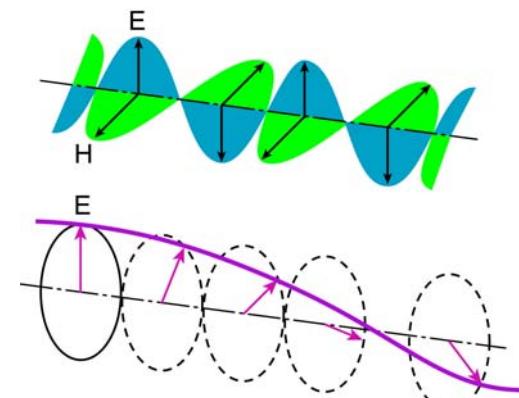
Angular divergence



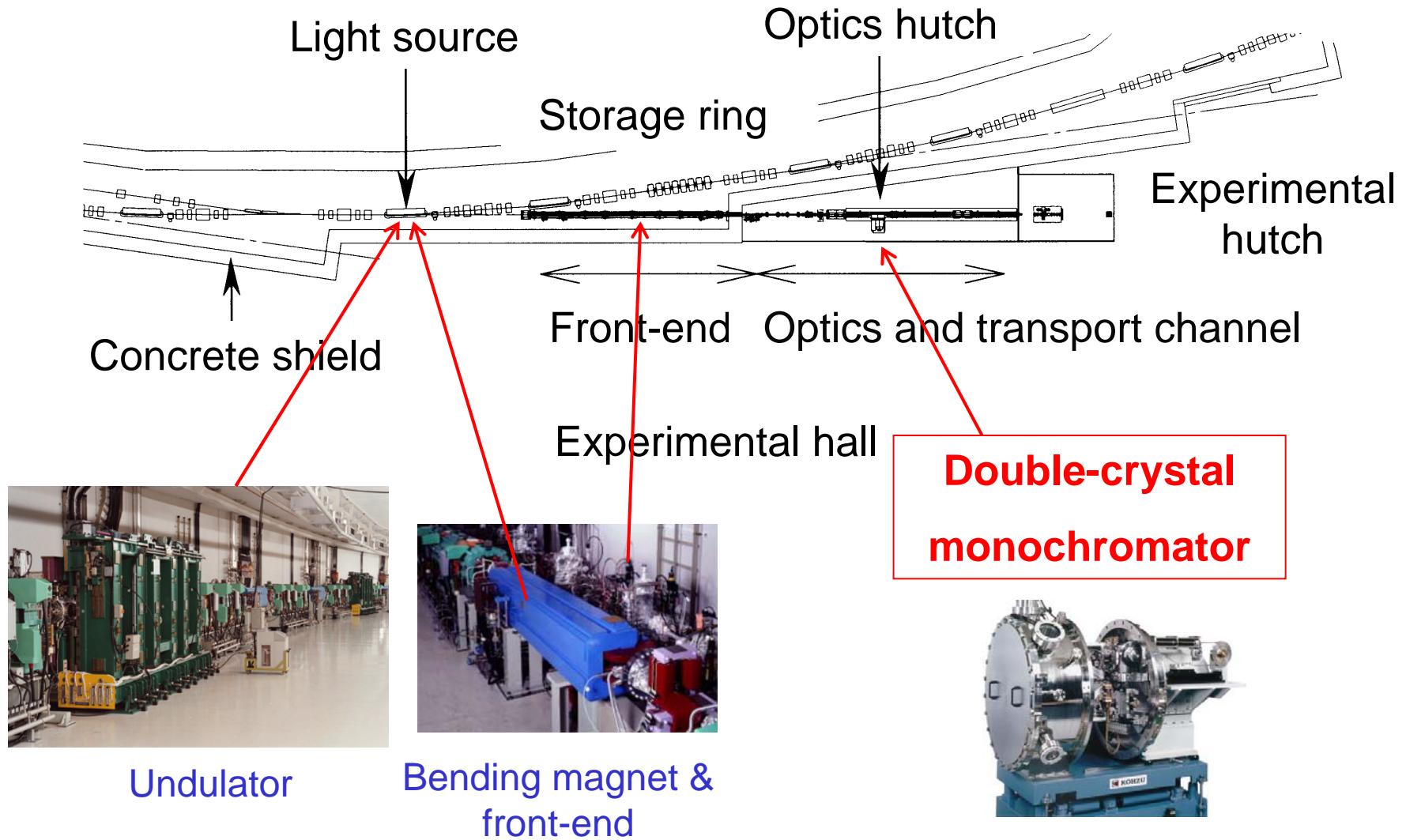
intensity



polarization



Example of beamline structure @SPring-8



Crystal monochromators

Bragg's law of diffraction

$$2d(\text{\AA})\sin(\theta) = n\lambda(\text{\AA}) = n \frac{12.4}{E(\text{keV})}$$

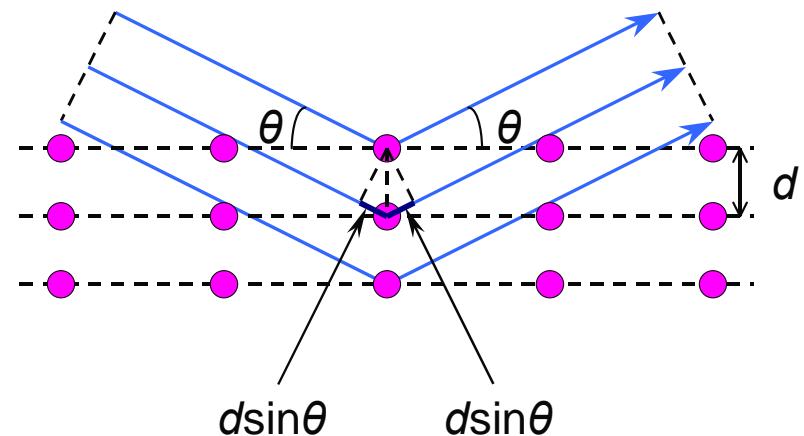
d : Lattice (d)-spacing,

θ : glancing angle,

λ : X-ray wavelength

10 keV : 1.24 Å,

1 Å : 12.4 keV



Energy (wavelength) resolution

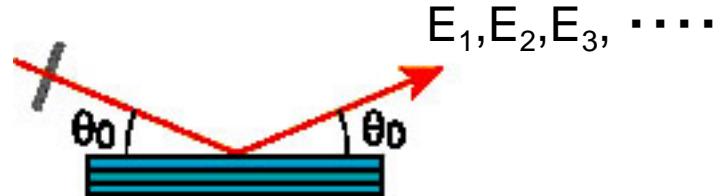
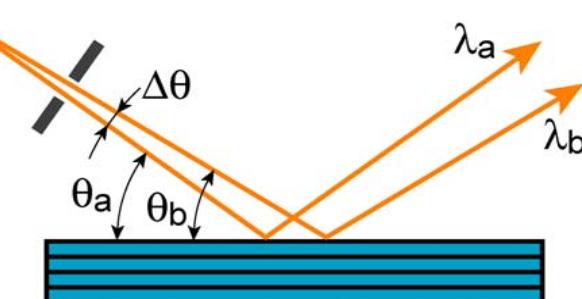
$$\frac{\Delta E}{E} = \frac{\Delta\lambda}{\lambda} = \Delta\theta \cot\theta$$

Higher harmonics

$$E_1 = 10 \text{ keV } (n = 1)$$

$$E_2 = 20 \text{ keV } (n = 2)$$

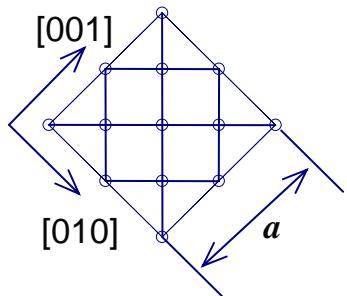
$$E_3 = 30 \text{ keV } (n = 3)$$



Lattice planes of silicon

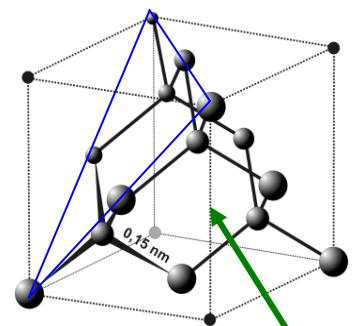


Top view

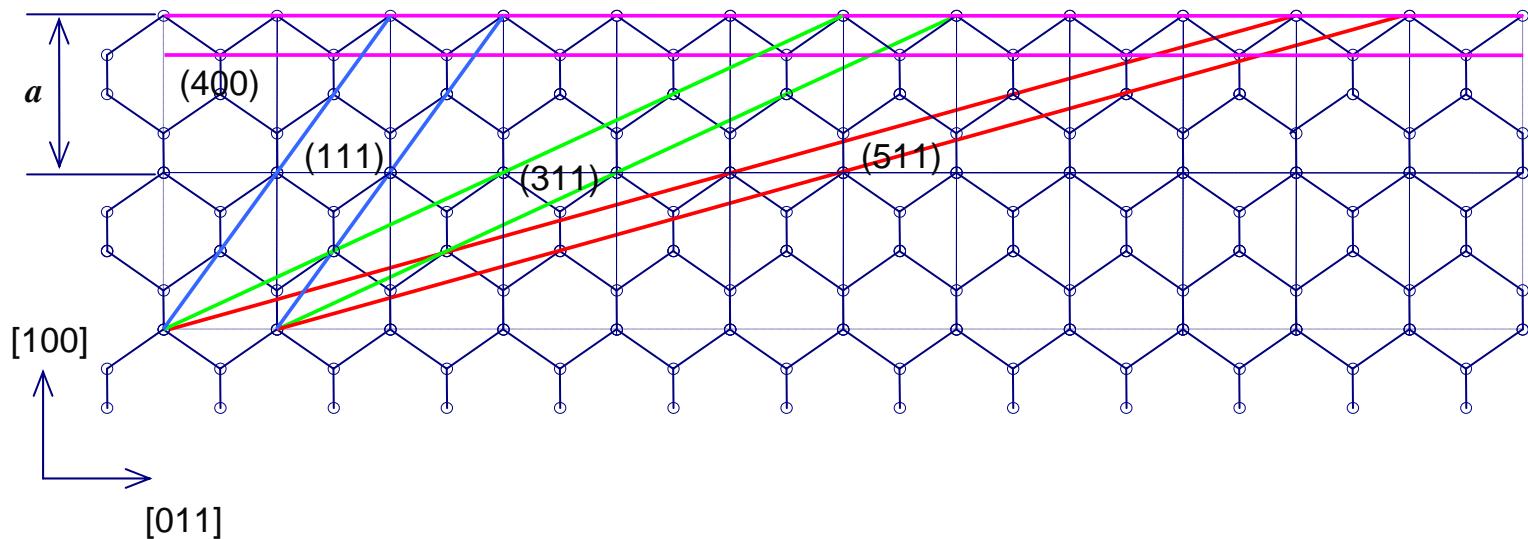


$$a_0 = 5.43095 \text{ \AA}$$

d -spacing
(400) : 1.3578 \text{ \AA}
(111) : 3.1356 \text{ \AA}
(311) : 1.6375 \text{ \AA}
(511) : 1.0452 \text{ \AA}



Side view



Energy range of SPring-8 standard monochromator

e.g. For SPring-8 standard monochromator

$$2d \sin(\theta) = n\lambda$$

→ Reflection

Si 111 : $d = 3.1356 \text{ \AA}$

Si 311 : $d = 1.6375 \text{ \AA}$

Si 511 : $d = 1.0452 \text{ \AA}$

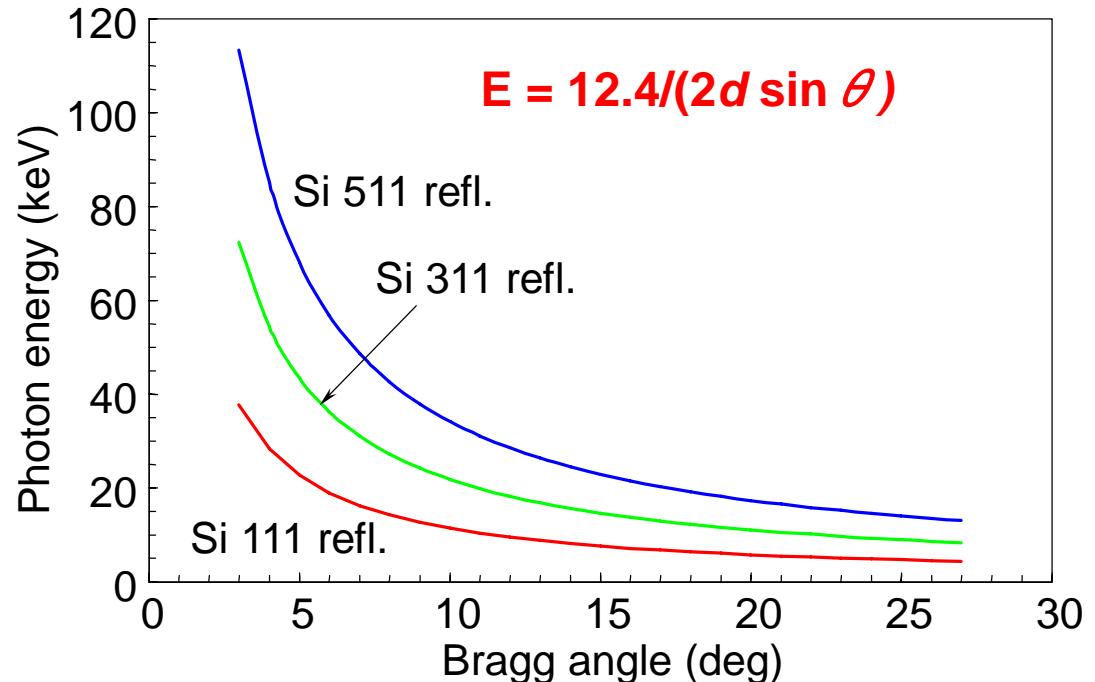
.....

→ Bragg angle

$3 \sim 27^\circ$

→ Energy range

$4.4 \sim 110 \text{ keV}$



Photon energy (wavelength) can be selected
by crystal, net planes, and Bragg angle.

Preparation of crystal monochromator

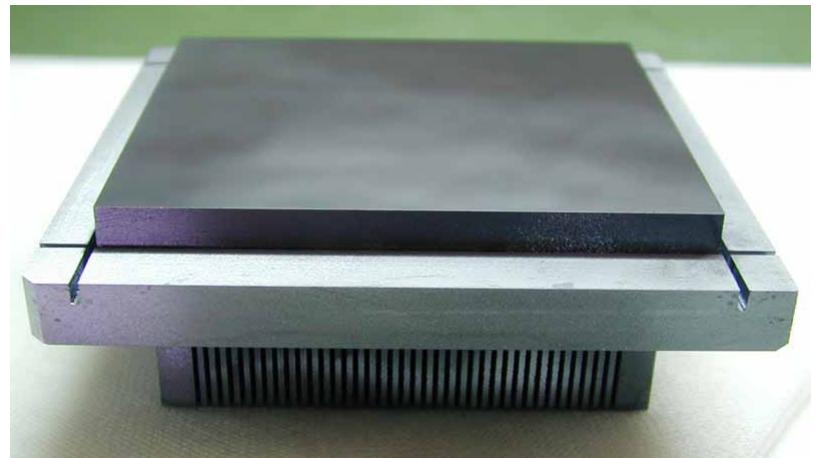
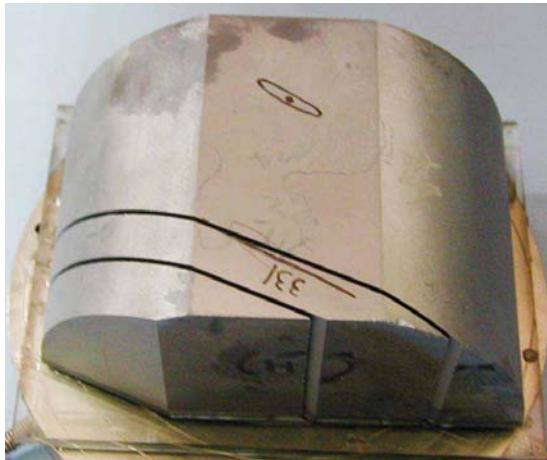
No or less imperfections

dislocations
stacking faults
point defects (non-uniformly distributed, striations, aggregations)

http://park.it.u-tokyo.ac.jp/lpc/SlicingMachine/SlicingMachine_F5120002.JPG



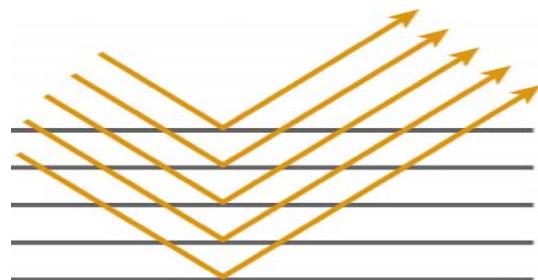
[http://park.it.u-tokyo.ac.jp/lpc/SlicingMachine/SlicingMachine_F5120002.JPG \(1/3\)2008/09/28 20:43:34](http://park.it.u-tokyo.ac.jp/lpc/SlicingMachine/SlicingMachine_F5120002.JPG (1/3)2008/09/28 20:43:34)



Courtesy of Sharan Instruments Co. Ltd.

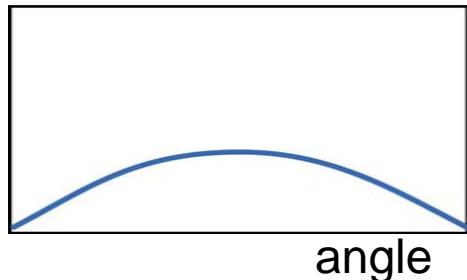
X-ray diffraction by a single crystal

Kinematical diffraction
(imperfect crystal,
small crystal)

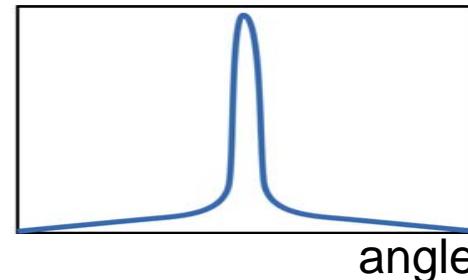
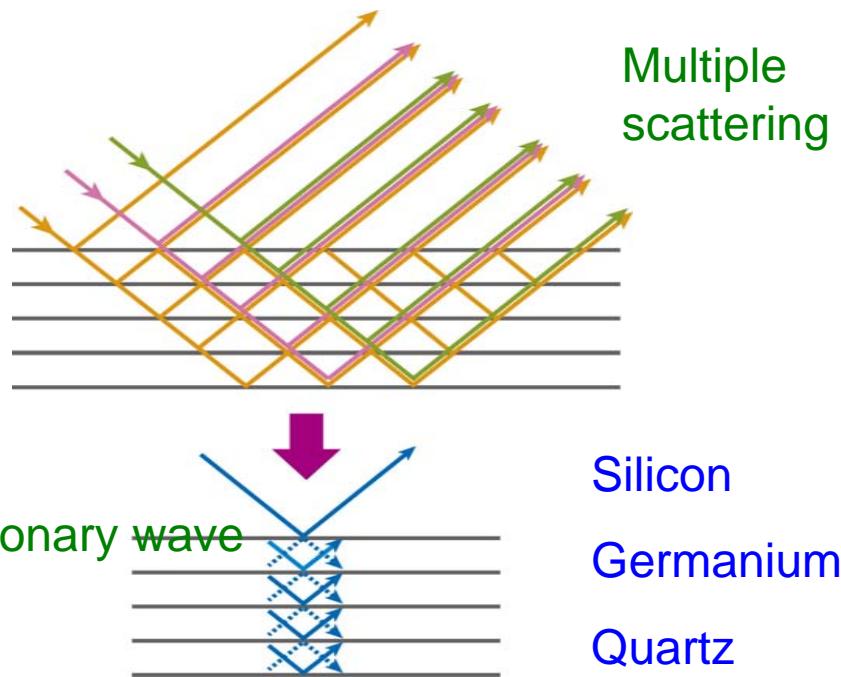


Single scattering

X-rays are scattered
only once in the
crystal.



Dynamical diffraction
(nearly perfect crystal)



X-Ray Dynamical Diffraction

- P. Ewald (1912, 1917):
dipoles in the crystal which are excited by the incident X-ray wave and radiate X-rays.
- C. Darwin (1914): multiple reflection by lattice planes.
- M. von Laue (1931) :
continuous medium consisting of periodic dielectric constant.
- Experimental proof: in 1960's and 1970's, big perfect crystals (silicon, germanium, etc) became available
- Since late 1970's, perfect crystals have been used as monochromators on synchrotron beamlines.

Textbooks and reviews

B. W. Batterman and H. Cole, Rev. Mod. Phys. 36, 681 - 717 (1964)

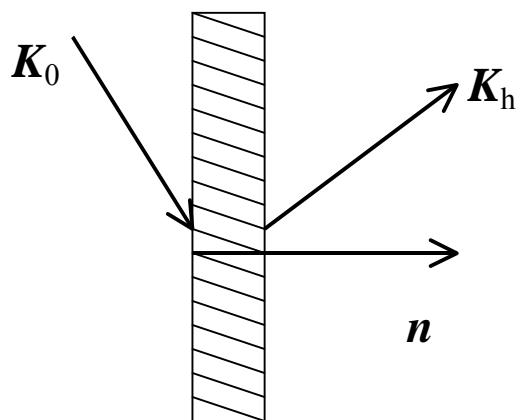
Dynamical Diffraction of X Rays by Perfect Crystals

A. Authier, Dynamical Theory of X-Ray Diffraction, International Union of Crystallography Monographs on Crystallography No. 11. Oxford: Oxford University Press, 2001

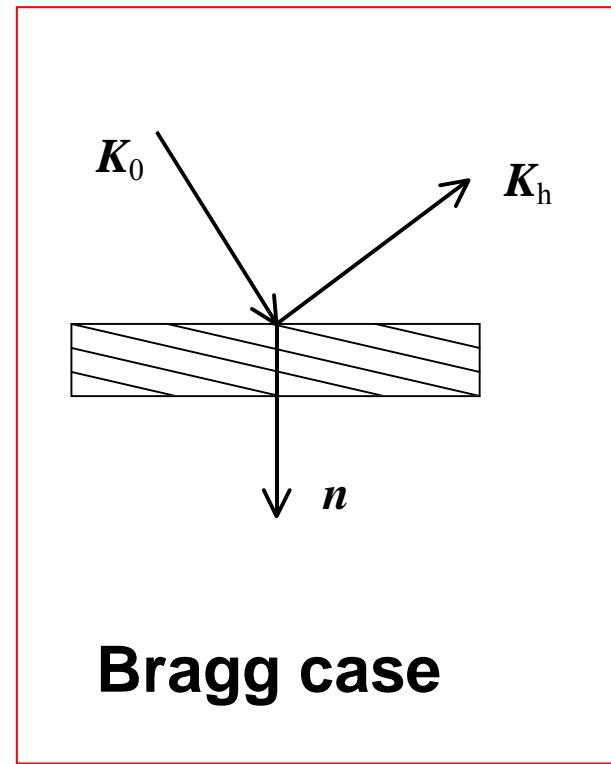
R. W. James: The Dynamical Theory of X-Ray Diffraction, in Solid State Physics (Seitz and Turnbull) vol.15 (1963), Academic Press

M. von Laue: *Roentgenstrahlen Interferenzen* , 1941

Laue case and Bragg case



Laue case

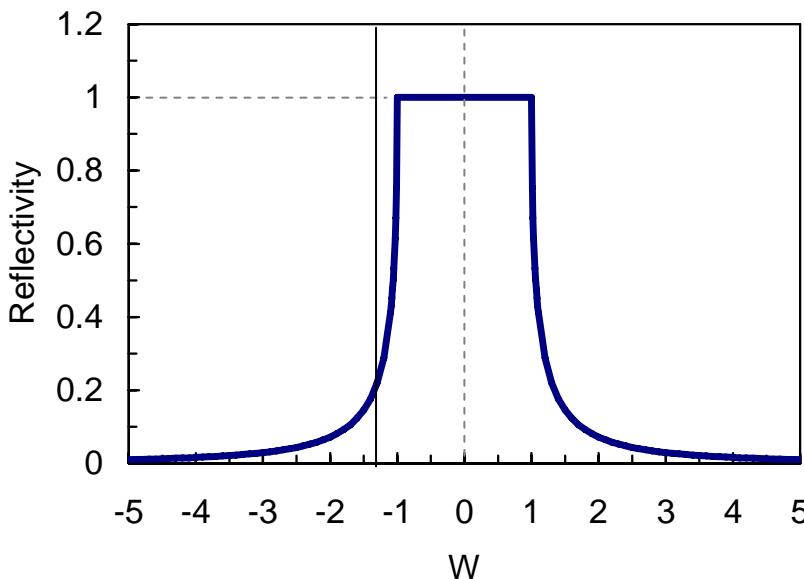


Bragg case

Reflectivity

reflectivity for Bragg case, no absorption, and thick crystal:

$$\left\{ \begin{array}{l} R = \frac{|\gamma_h|}{\gamma_0} \left| \frac{E_h}{E_0} \right|^2 = \left(W + \sqrt{W^2 - 1} \right)^2 \quad (W < -1) \\ R = 1 \quad (-1 \leq W \leq 1) \quad \leftarrow \text{Total reflection} \\ R = \left(W - \sqrt{W^2 - 1} \right)^2 \quad (W > 1) \end{array} \right.$$



$$\chi_{hr} = \frac{e^2 \lambda^2}{\pi m c^2 V} F_{hr} e^{-M}$$

$$\chi_{0r} = \frac{e^2 \lambda^2}{\pi m c^2 V} F_{0r}$$

For symmetric Bragg case, sigma polarization:

$$W = \{\Delta\theta \sin 2\theta_{BK} + \chi_{0r}\} \frac{1}{|\chi_{hr}|}$$

Darwin width $\rightarrow \Delta W = 2$

$$\omega = \frac{2|\chi_{hr}|}{\sin 2\theta_{BK}} \propto |F_h|$$

Shift of Bragg angle due to refraction:

$$\Delta\theta_{refraction} = -\frac{\chi_{0r}}{\sin 2\theta_{BK}}$$

Silicon single crystal, E = 10 keV

hkl	Bragg angle (degree)	ω (arc sec)	ω (μ rad)
111	11.403	5.476	26.55
220	18.836	3.984	19.32
311	22.246	2.273	11.02
400	27.167	2.495	12.10
422	34.001	1.886	9.142
333	36.379	1.228	5.952
440	40.22	1.543	7.479

χ 0h on the web!!!

<http://sergey.gmca.aps.anl.gov/x0h.html>

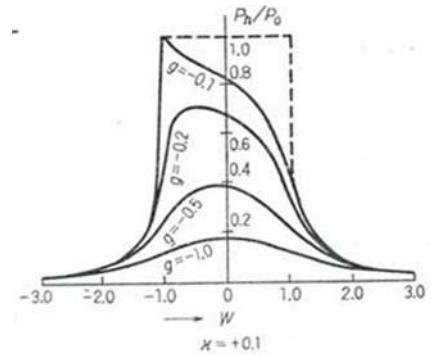
For thick absorbing crystal in the Bragg-case (reflection geometry), the reflectivity is given by

$$R = L - \sqrt{L^2 - (1 + 4\kappa^2)}$$

$$L - \sqrt{(W^2 - 1 - g^2)^2 + 4(gW - \kappa)^2} + W^2 + g^2$$

$$\kappa = \frac{\chi_{hi}}{\chi_{hr} r}$$

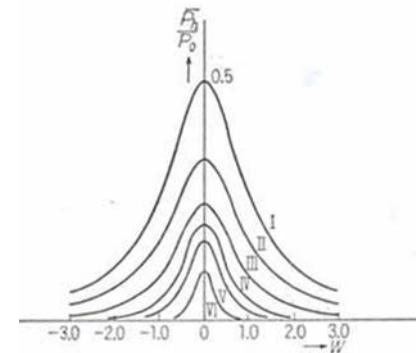
$$g = \frac{\chi_{0i}}{|\chi_{hr}|}$$



For thin absorbing crystal of the Laue-case (transmission geometry), the reflectivity is given by

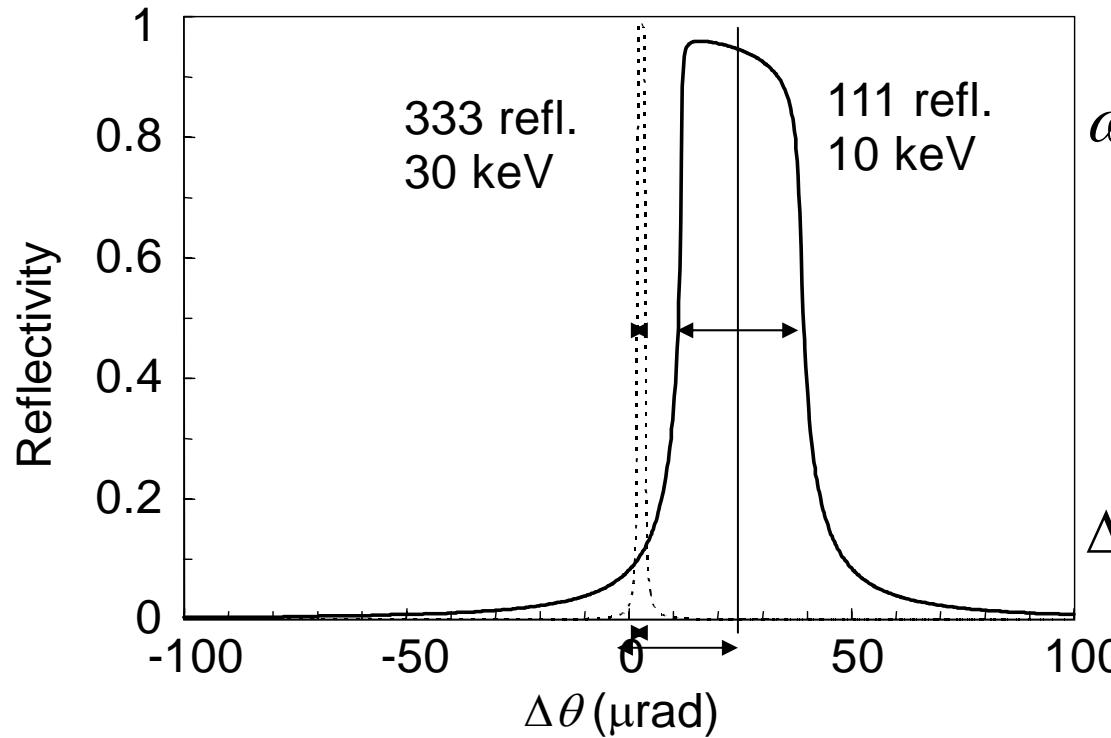
$$R_T = \frac{\exp(-\mu t / \gamma)}{(1 + W^2)} \left[\sin^2(A\sqrt{1 + W^2}) + \sinh^2 \frac{\kappa A}{\sqrt{1 + W^2}} \right]$$

$$A = \pi k |\chi_{hr}| t / \gamma$$



Intrinsic rocking curve for silicon

Based on the dynamical theory for perfect crystal
for thick crystal and absorption considered:



$$\omega = \frac{2|\chi_{hr}|}{\sin 2\theta_{BK}}$$

$$\chi_{hr} = \frac{e^2 \lambda^2}{\pi m c^2 V} F_{hr} e^{-M}$$

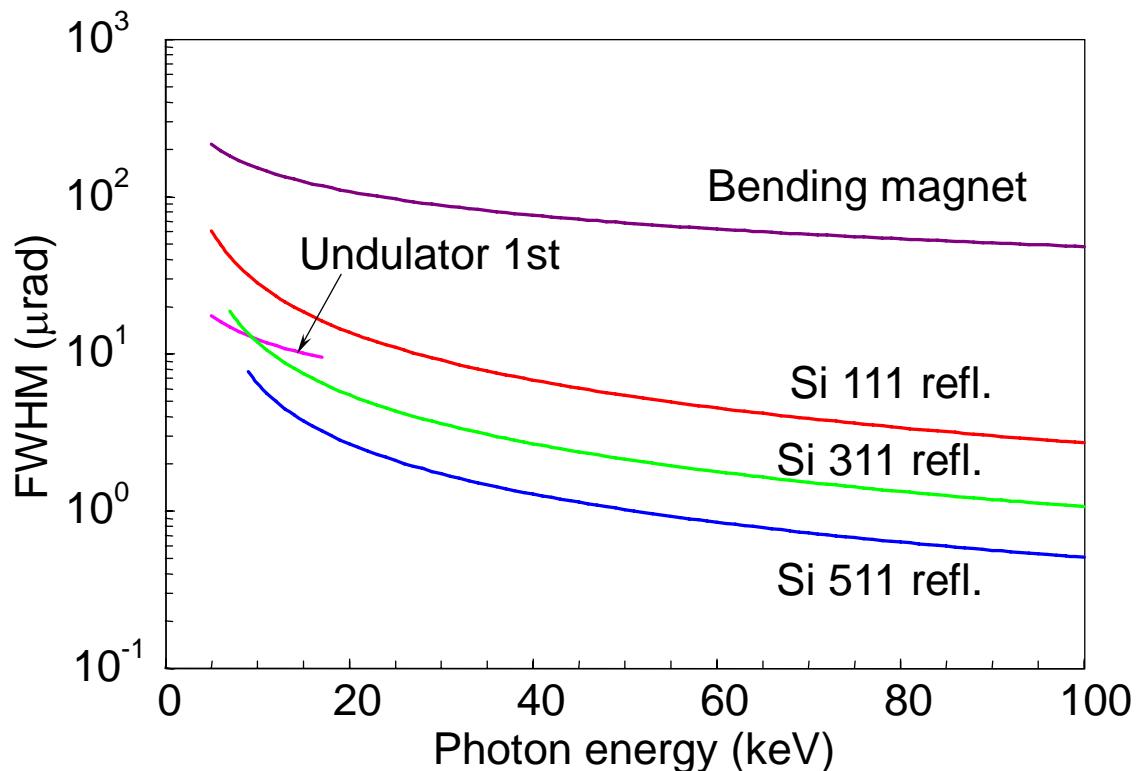
$$\Delta\theta_{refraction} = -\frac{\chi_{0r}}{\sin 2\theta_{BK}}$$

$$\chi_{0r} = \frac{e^2 \lambda^2}{\pi m c^2 V} F_{0r}$$

Features:

- Diffraction width (Darwin width) of $0.1 \sim 100 \mu\text{rad}$
- Peak reflectivity of ~ 1 for low absorption case

Angular divergence of sources and diffraction width



SPring-8 bending magnet

$$\sigma_r \approx \frac{1}{\gamma} \approx 60 \mu\text{rad}$$

Undulator ($N=140$)

$$\sigma_r \approx \frac{1}{\gamma \sqrt{N}} \approx 5 \mu\text{rad}$$

Divergence of undulator radiation is the same order as diffraction width of low order reflection.

Energy resolution

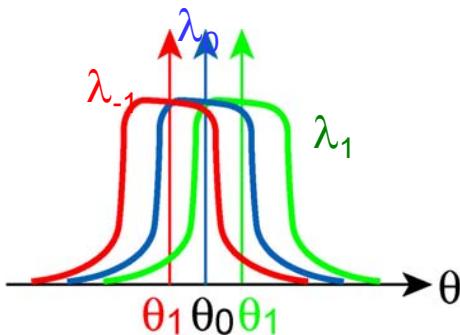
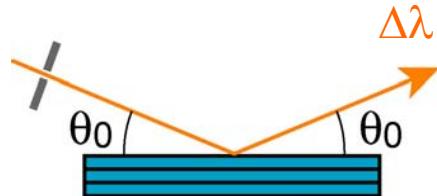
$$\Delta E/E = 10^{-5} \sim 10^{-3}$$

$$\frac{\Delta E}{E} = \cot \theta_B \sqrt{\omega^2 + \Delta\theta^2}$$

ω : intrinsic angular width of diffraction

$\Delta\theta$: angular divergence of X-ray beam

(1) ω



$$2d \sin(\theta_0) = \lambda_0$$

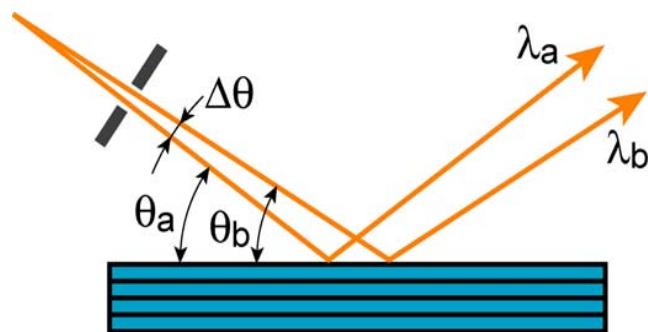
$$2d \sin(\theta_{-1}) = \lambda_{-1}$$

$$2d \sin(\theta_1) = \lambda_1$$

For Si 111, $\omega = 2.66 \times 10^{-5}$ rad at 10 keV

$$\Delta E/E = \omega \cot \theta = 2.66 \times 10^{-5} \times \cot(11.4^\circ) = 1.32 \times 10^{-4}$$

(2) $\Delta\theta$



source-to-slit distance = 30 m

slit width = 1 mm

$$\Delta\theta = 3.3 \times 10^{-5}$$

Si 111, 10 keV: $\theta = 11.4^\circ$

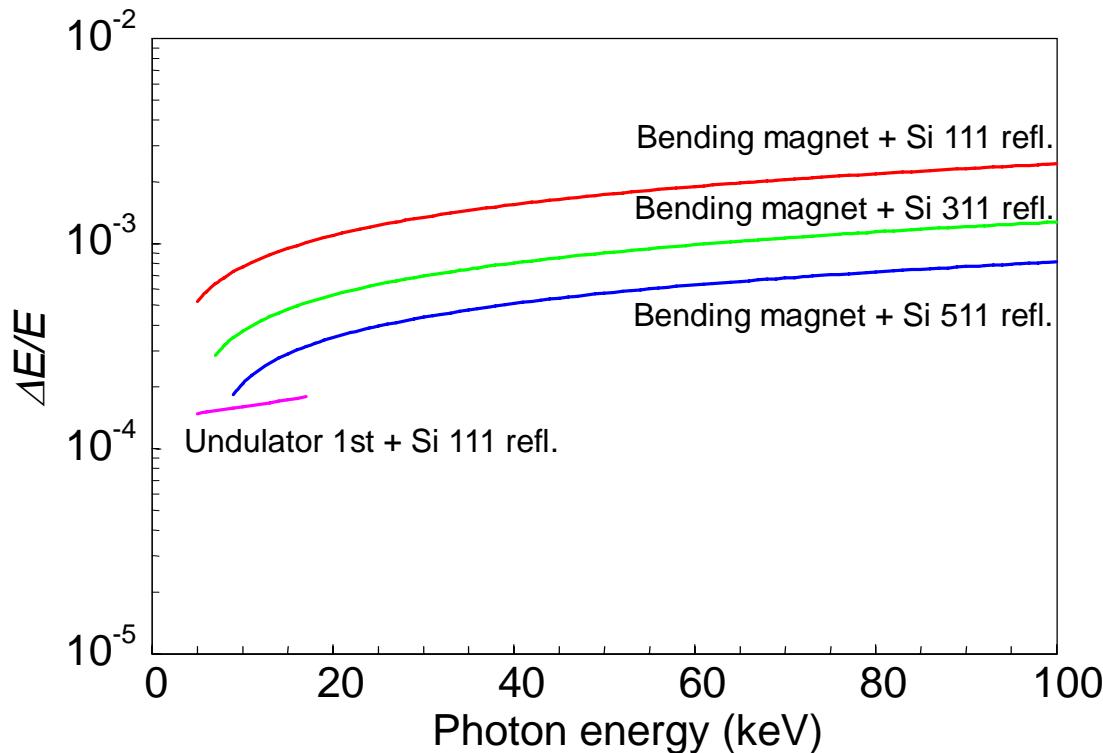
$$\Delta E/E = \Delta\theta \cot \theta = 1.6 \times 10^{-4}$$

Energy resolution

$$\frac{\Delta E}{E} = \cot \theta_B \sqrt{\Omega^2 + \omega^2}$$

Ω : divergence of source

ω : diffraction width



Using slit, collimator mirror,.. we can reduce Ω_{eff} ,

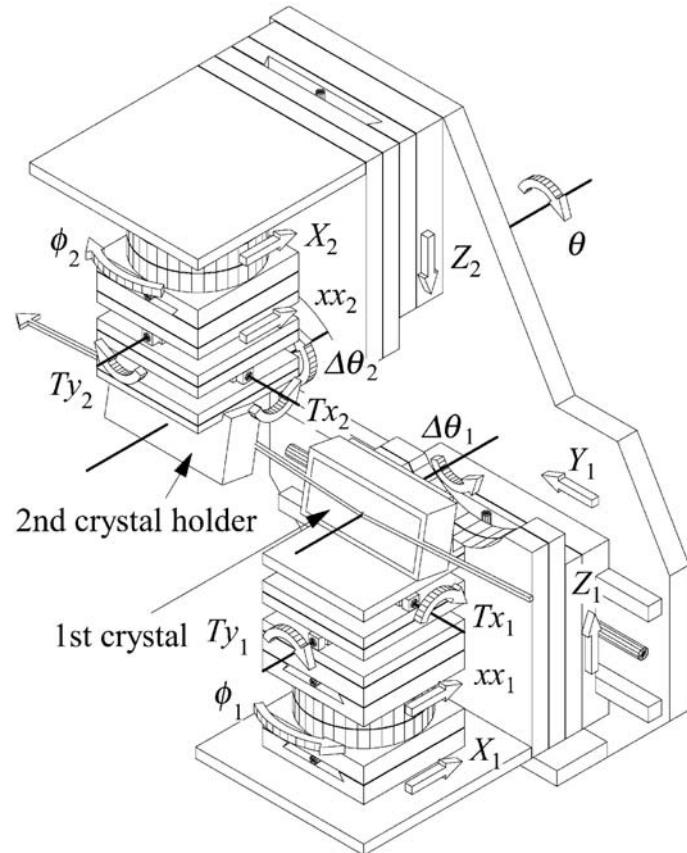
$$\Delta E/E = 10^{-5} \sim 10^{-3}$$

SPring-8 standard DCM



$3^\circ < \theta_B < 27^\circ$

Offset $h = 30$ mm



Adjustment stages
for undulator beamline DCM
Sub-micron, sub- μ rad control

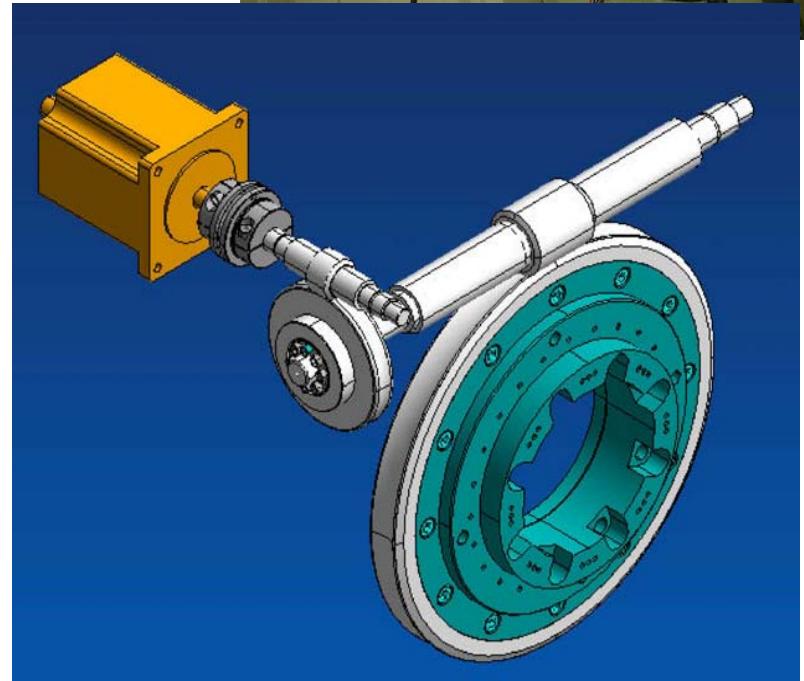
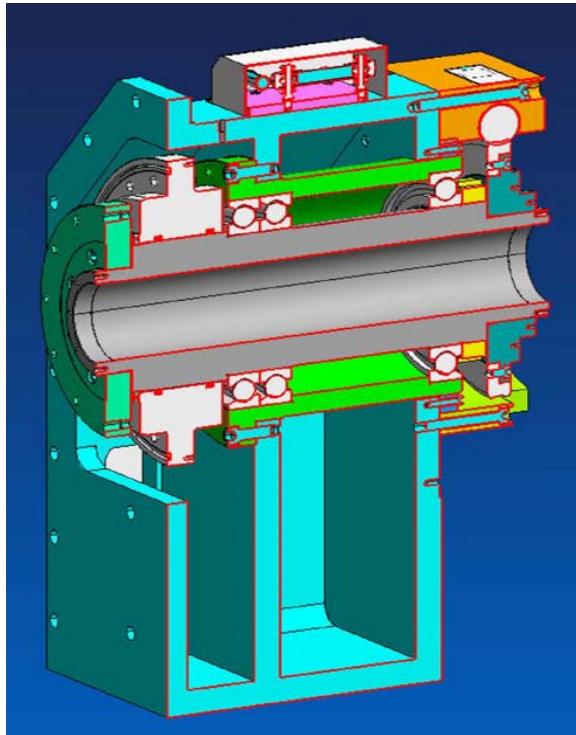
Goniometer and angle accuracy

Energy scan (Si 111 d = 3.119478 Å)

$$E_0: 10.000 \text{ keV} \quad \theta = 11.46246^\circ$$

$$E_1: 10.001 \text{ keV} \quad \theta = 11.46130^\circ$$

$$\Delta\theta = 0.001162^\circ = 4.18 \text{ arc s} = 20.3 \mu\text{rad}$$

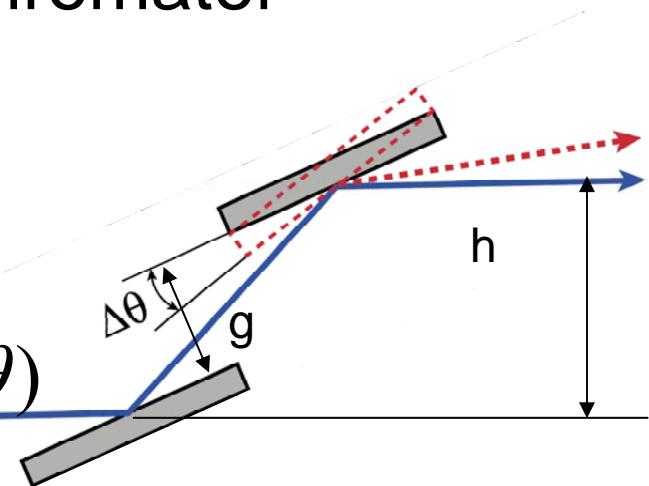


0.2 arc s / step (1 μrad / step)

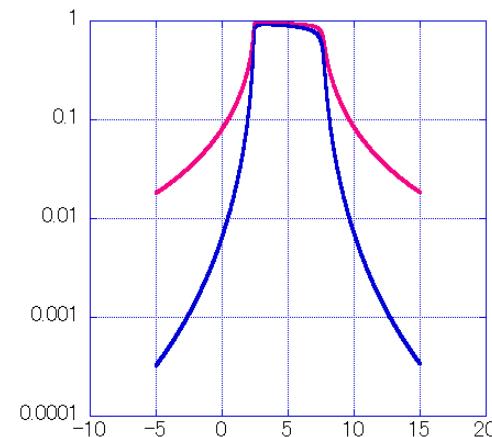
Courtesy of Kohzu Seiki Co. Ltd.

Double crystal monochromator

- Constant beam direction
- beam height changes slightly when E is changed.
- Two crystals should be parallel to each other within sub-arc-seconds.
- Tail intensity falls off rapidly.

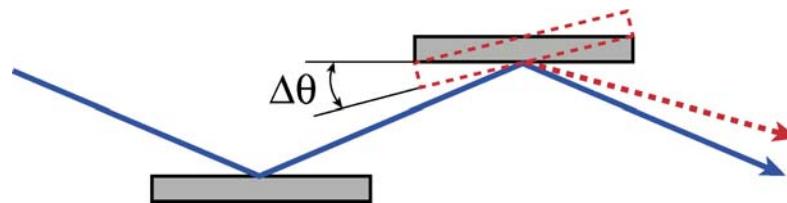


$$h = 2g \cos(\theta)$$

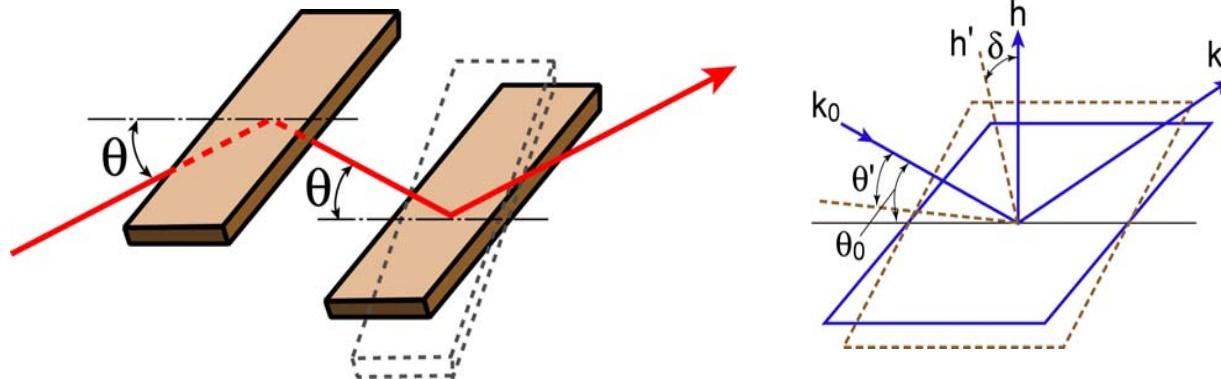


Alignment of a double crystal monochromator

(1) Parallelity in the scattering plane: sub- μ rad

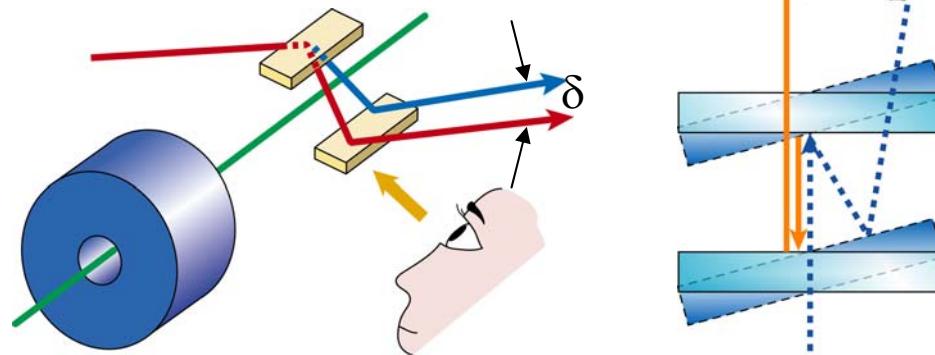


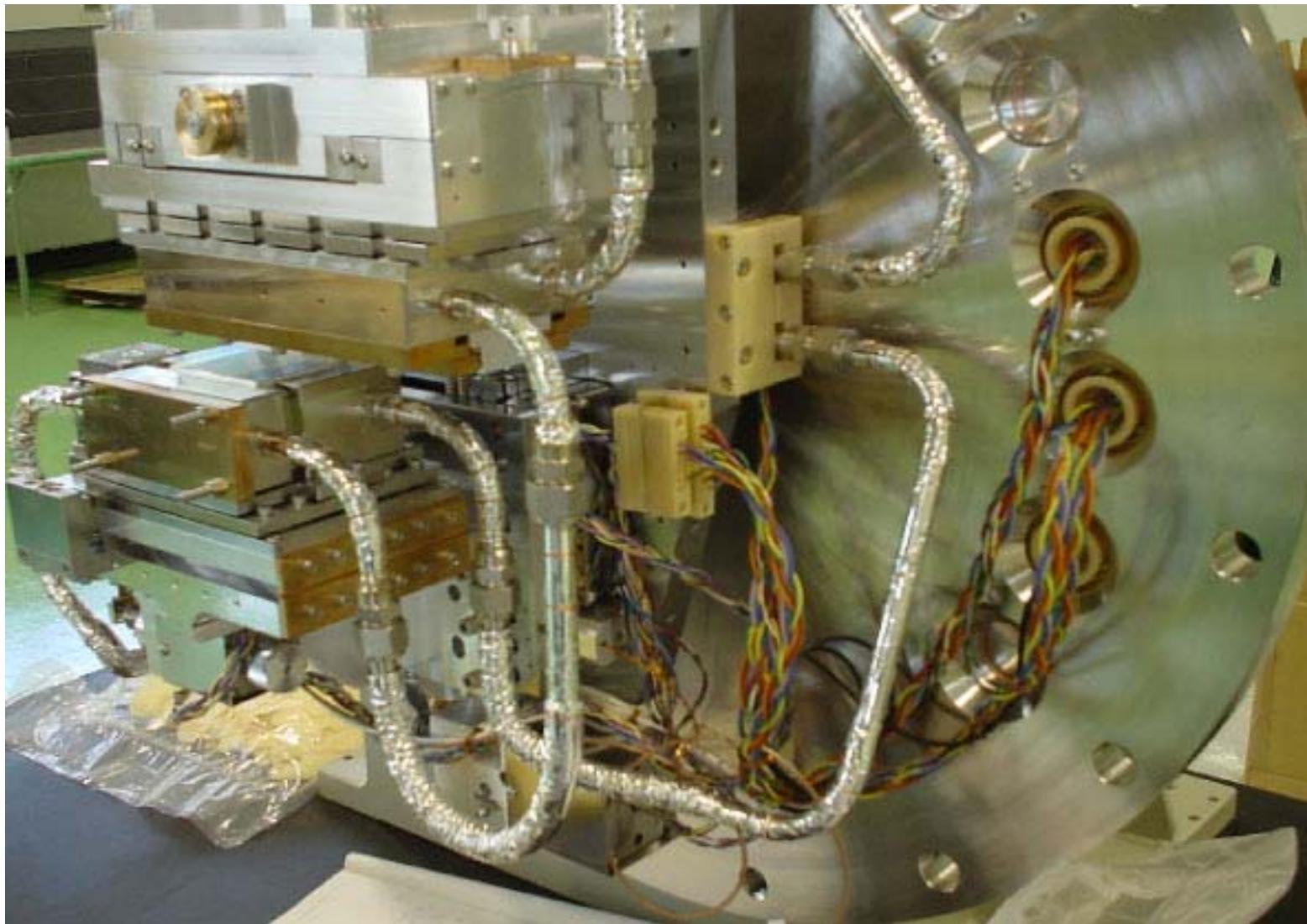
(2) Parallelity normal to the scattering plane: $\sim 10^{-3} - 10^{-4}$ rad



(3) Parallelity to the rotating axis :

$\psi: 10^{-3} - 10^{-4}$





Courtesy of Kohzu Seiki Co. Ltd.

Stability and disturbances

Variation at the sample

- Energy :
 0.1 eV for XAFS,
 sub-meV for high resolution inelastic scattering
- Intensity : less than 1 %.
- Beam position: typically several tens ~ 1 μm

Source instability

Source size change, source position change, charge distribution change

Room temperature variation

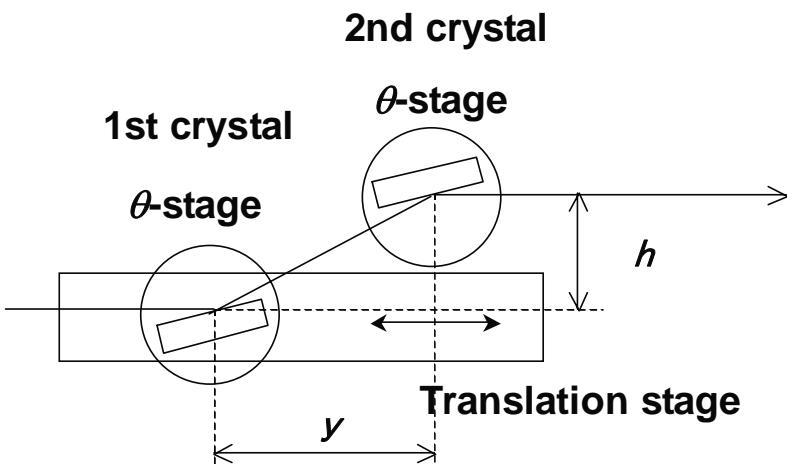
Heat load by the radiation itself

Vibration

floor, cooling water, vacuum pump

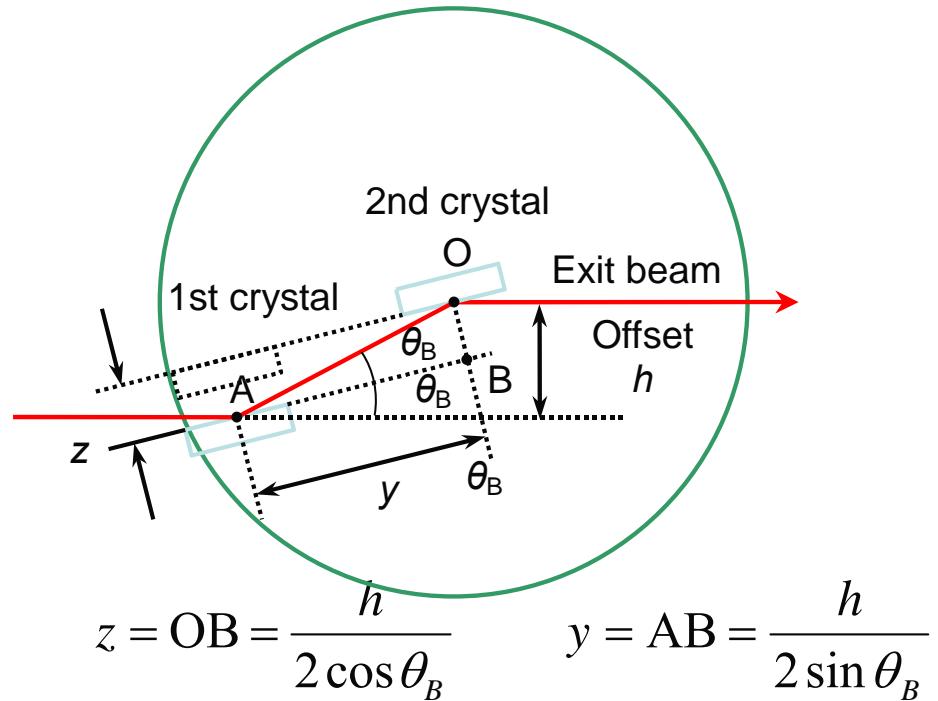
Fixed-exit DCM

(1) $\theta_1 + \text{translation} + \theta_2 \text{link}$



$$y = \frac{h}{\tan 2\theta_B}$$

(2) $\theta + \text{two translation link}$



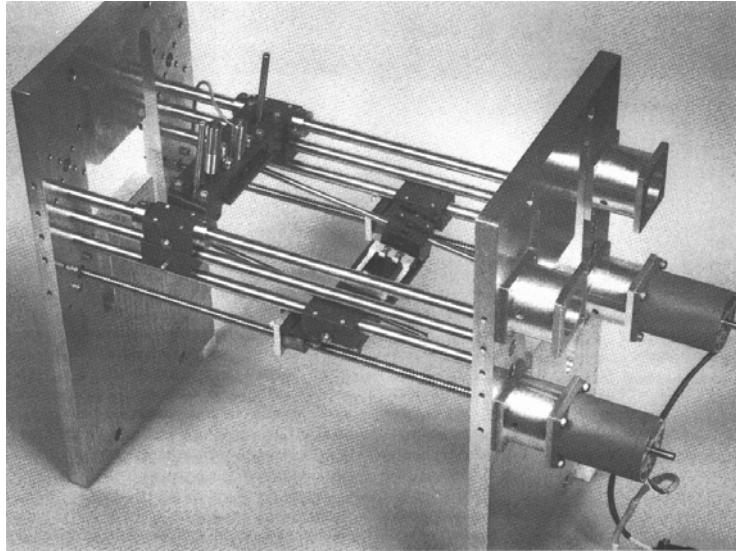
$$z = OB = \frac{h}{2 \cos \theta_B}$$

$$y = AB = \frac{h}{2 \sin \theta_B}$$

$$(y^2 - h^2 / 4)(z^2 - h^2 / 4) = h^4 / 16$$

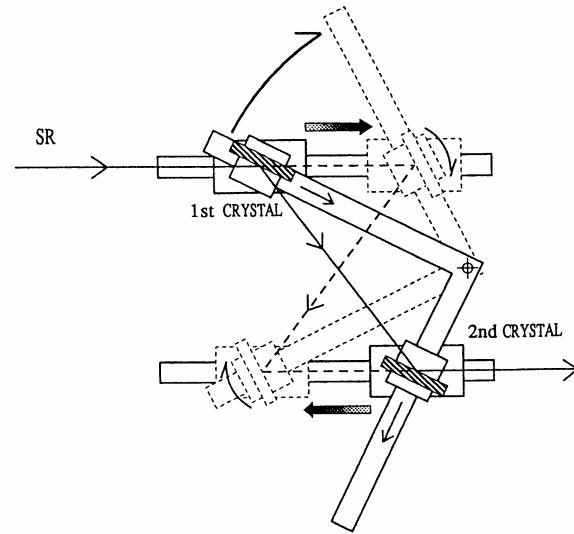
A number of different schemes have been developed to realize a fixed-exit beam.

Boomerang link type



Kirkland, NIM-A291 (1990)

$$h = 50 \text{ mm}, \theta_B = 5 \sim 85^\circ$$



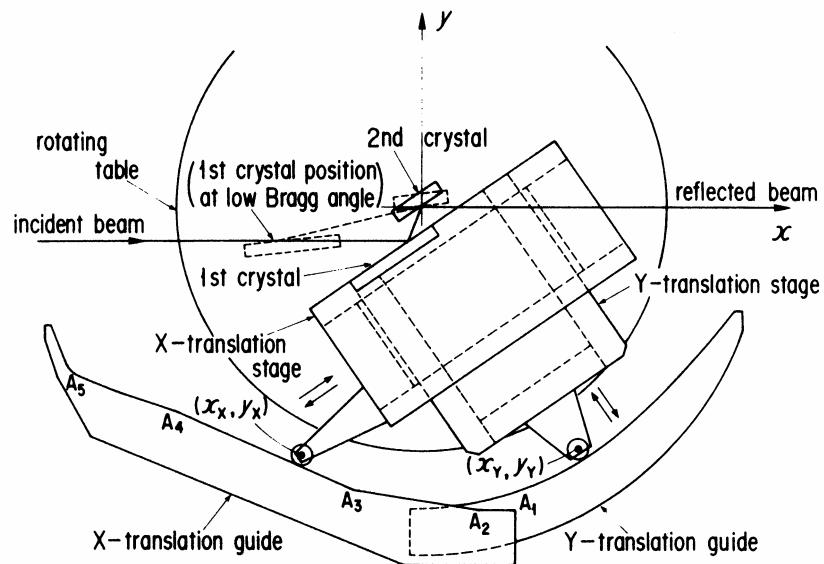
UVSOR BL 1A, BL 7A

Hiraya et al., RSI 66 (1995)

$$\theta_B = 18.5 \sim 71.5^\circ$$

- Difficulties for crystal cooling and multi-stage adjustment
- Low rigidity

$\theta +$ two translation (KEK-PF)



PF BL-4C..

Matsushita et al., NIM A246 (1986)

$h = 25 \text{ mm}$, $\theta_B = 5 \sim 70^\circ$

Two cams for two translation-stages
Rotation center at 2nd crystal

Heat load on 1st Crystal

Heat load on the mochromator 1st crystal:

→ For SPring-8 bending magnet source
100 W & 1 W/mm²

→ For SPring-8 standard undulator source
~500 W & ~ 500 W/mm²

cf. Hot plate : ~ 0.02 W/mm²
 CPU : ~ 0.3 W/mm²

Crystal cooling

Why crystal cooling ?

$$Q_{in} \text{ (Heat load by SR)} = Q_{out} \text{ (Cooling + Radiation,...)}$$

→ with temperature rise ΔT

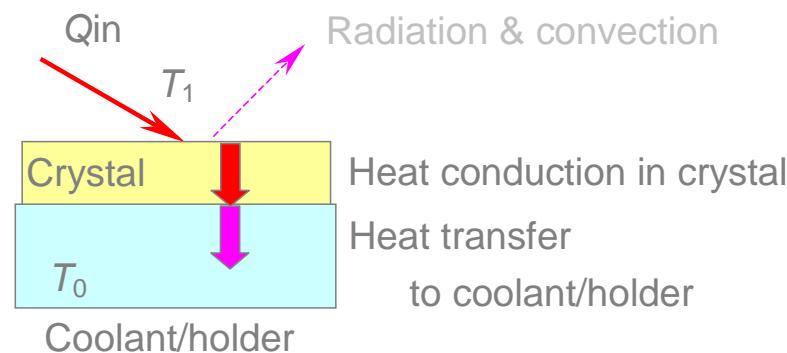
→ $\alpha \Delta T = \Delta d$ (d -spacing change)

α : thermal expansion coefficient

or → $\Delta \theta$ (bump of lattice due to heat load)

Miss-matching between 1st and 2nd crystals occurs:

- Thermal drift, Loss of intensity, Broadening of beam, loss of brightness
- Melting or limit of thermal strain → **Broken !**



Solution for crystal cooling

We must consider:

Thermal expansion of crystal: α ,

Thermal conductivity in crystal: κ ,

Heat transfer to coolant and crystal holder.

Solutions:

(S-1) $\kappa/\alpha \rightarrow$ Larger

(S-2) Large contact area between crystal and coolant/holder
 \rightarrow larger

(S-3) Irradiation area \rightarrow Larger, and power density \rightarrow smaller

Figure of merit

	Silicon	Silicon	Diamond	Copper
	300 K	80 K	300 K	300 K
κ (W/m/K)	150	1000	2000	401
α (1/K)	2.5×10^{-6}	-5×10^{-7}	1×10^{-6}	16.5×10^{-6}
$\kappa / \alpha \times 10^6$	60	2000	2000	24

Figure of merit of cooling:
Good for silicon (80 k) and diamond (300 K)

For SPring-8 case

Bending magnet beamline

Power and density : ~ 100 W, ~ 1 W/mm² @40 m

Method:

→ Direct cooling with fin crystal

← S-2

Undulator beamline

(Linear undulator, $N= 140$, $\lambda_u= 32$ mm)

Power and density : ~ 500 W , ~ 500 W/mm 2 @40 m

Methods:

→ Direct cooling of silicon pin-post crystal

← S-2

+ Rotated inclined geometry (\rightarrow 10 W/mm 2)

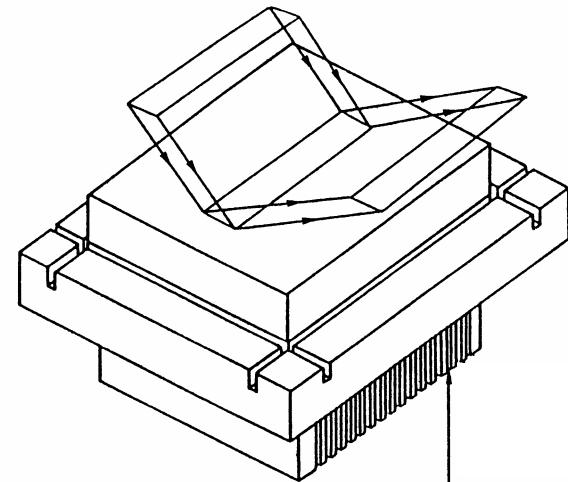
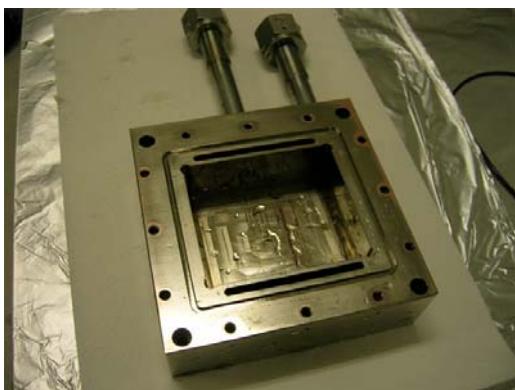
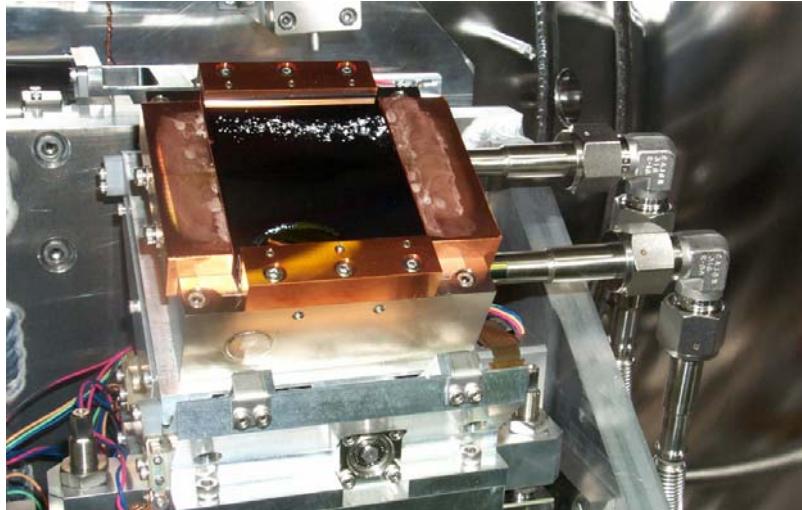
← S-3

→ or Cryogenic cooling using LN₂ circulation

← S-1

→ or Indirect cooling of IIa diamond crystal

Direct cooling with fin crystal



Fins with
Inserted metal

Applied to bending magnet beamline

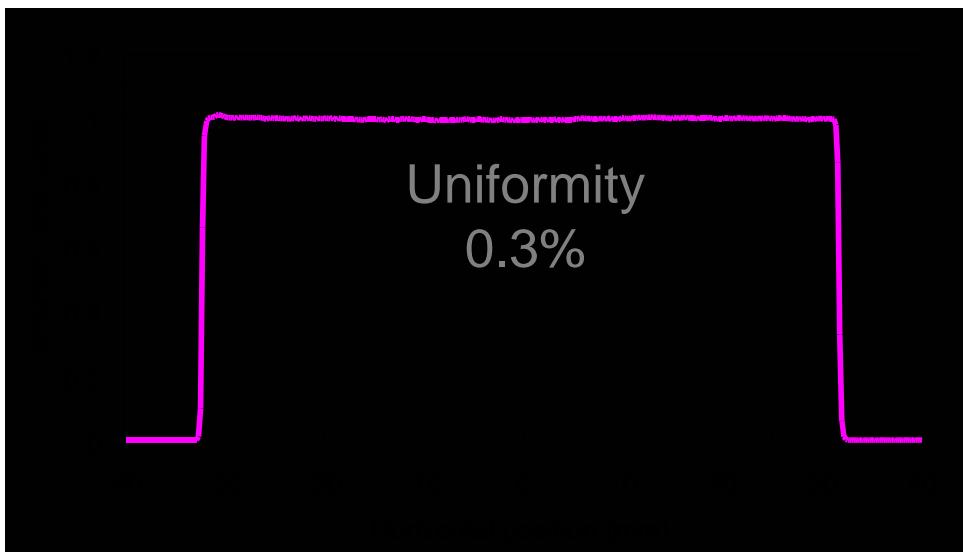
Performance of fin crystal (1)



Si 111 refl.



Si 333 refl.



$h\nu = 25$ keV

Si 111 refl.

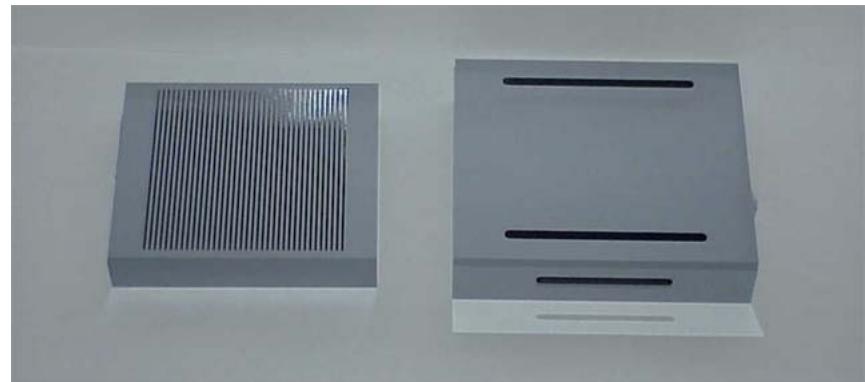
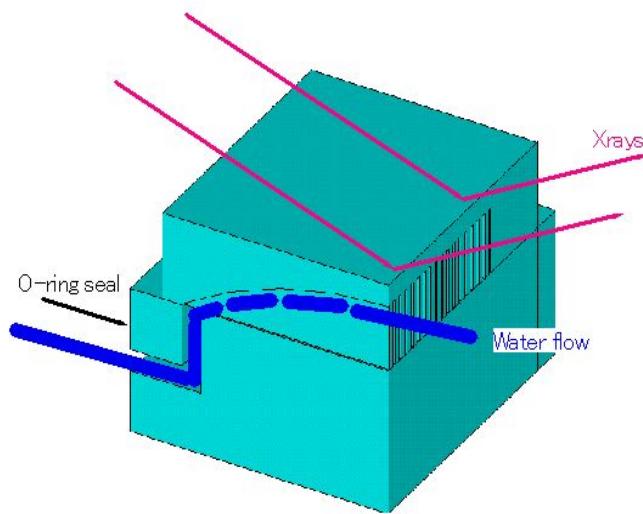
Ring current= 1 mA

Mechanical deformation removed

Direct cooling with fin crystal

Improvement of fin-cooling crystal

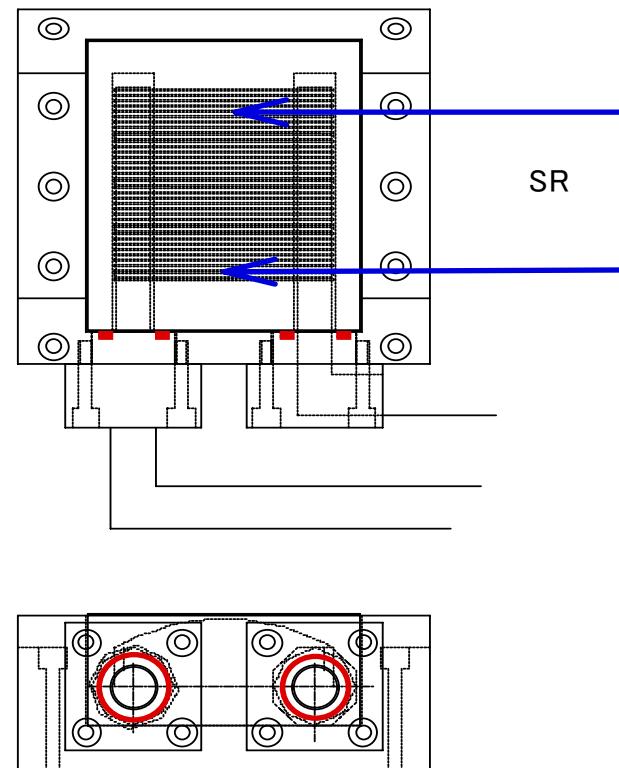
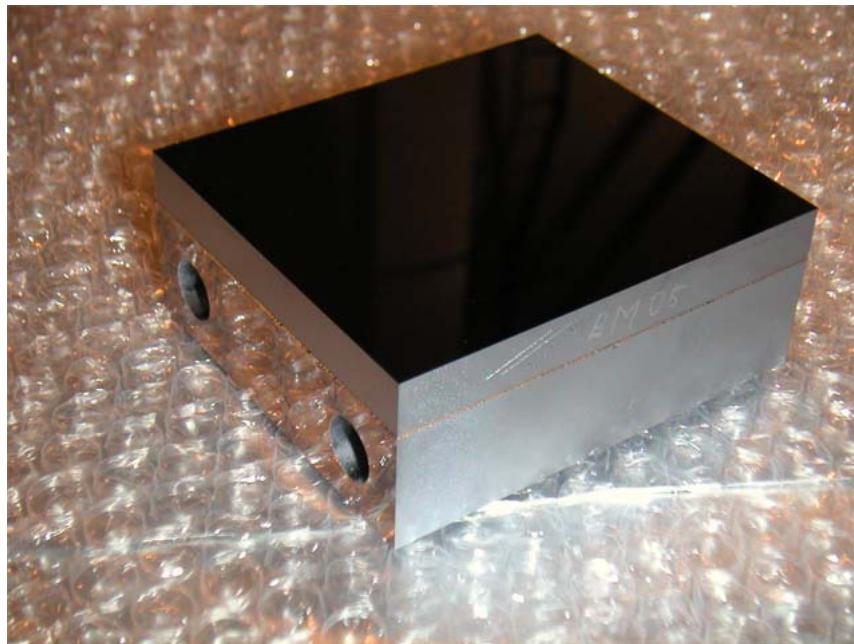
Reduce radiation damage of rubber O-ring



**Au-Si eutectic
bonding**

Direct cooling with fin crystal

Reduce radiation damage of rubber O-ring



Performance of fin crystal (2)

X-ray image for Si 311 refl.



$\theta_B = 5^\circ$, $E = 43.4$ keV



$\theta_B = 10^\circ$, $E = 21.8$ keV



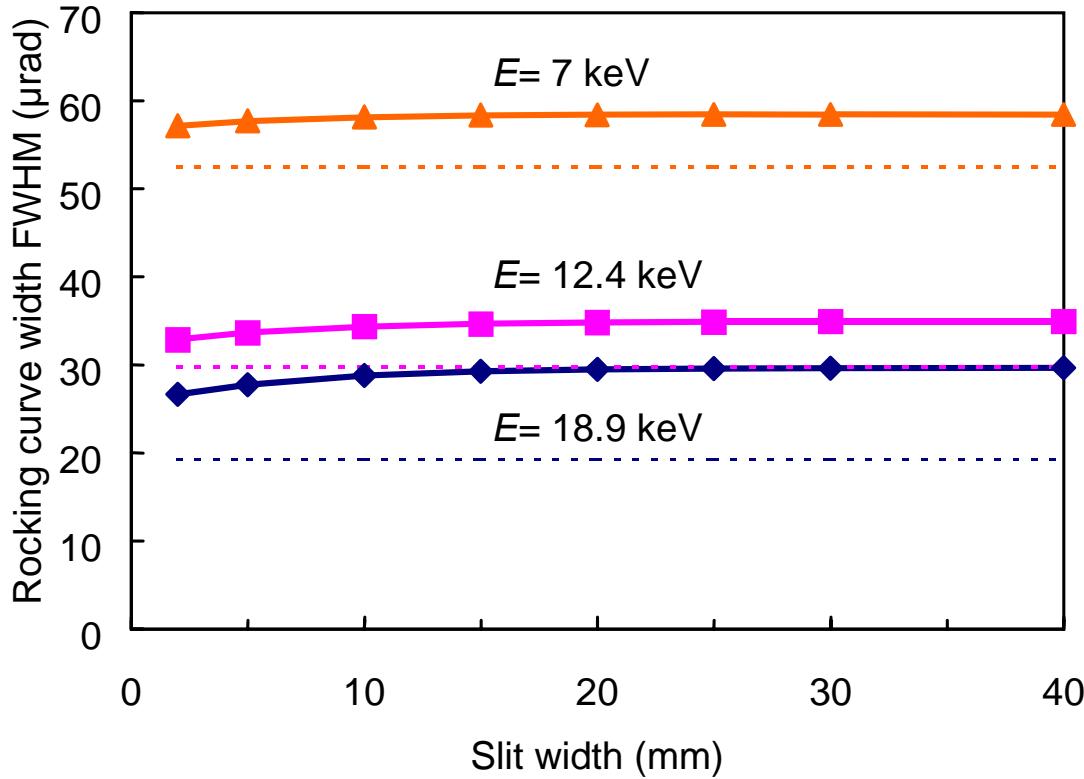
$\theta_B = 20^\circ$, $E = 11.1$ keV

Slit: 3 mm^V × 40 mm^H

Current status

- Practical use both (311) and (111) crystals
- 2~4 sec. twist due to fabrication process must be reduced.
- No heat strain for (111) crystal at 12 keV photon
- Radiation damage of O-ring is improved by side-inlet.
- Durability test is under way.

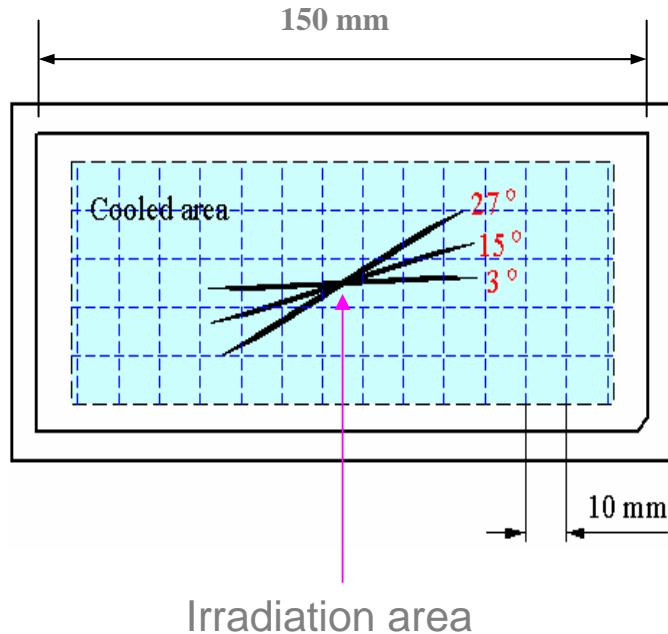
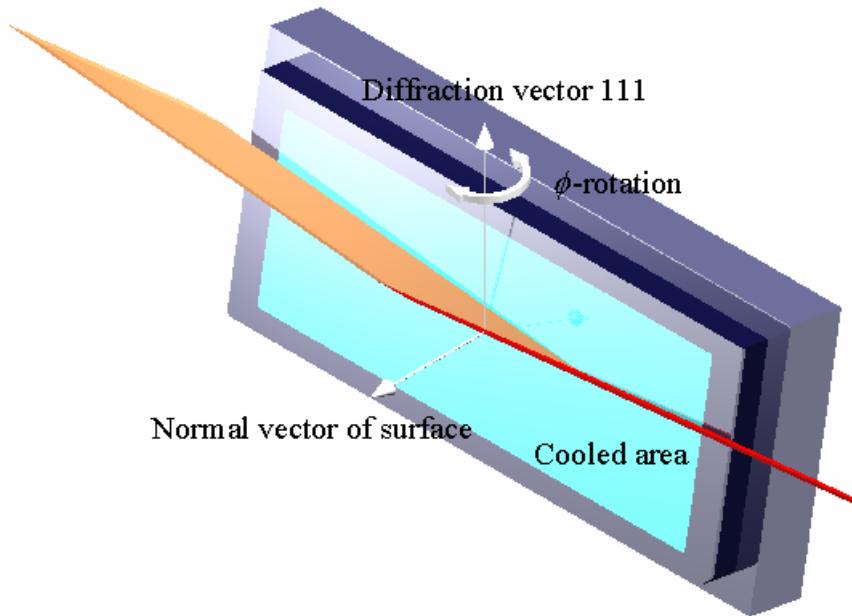
Performance of fin crystal (3)



Si 111 refl.

Ring current= 100 mA

Direct cooling of silicon pin-post crystal + Rotated inclined geometry



Inclination angle $\beta = 80^\circ$

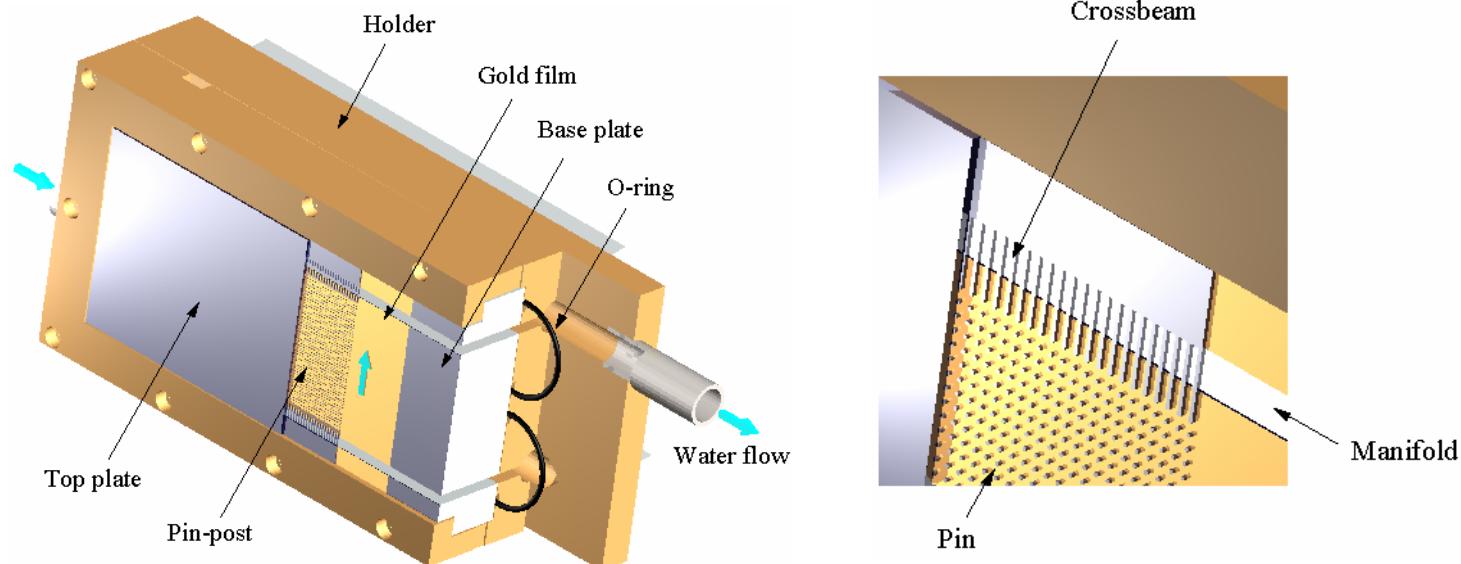
Grazing angle down to 1° using ϕ -rotation

Irradiation area enlarged to x50, power density reduced to 1/50

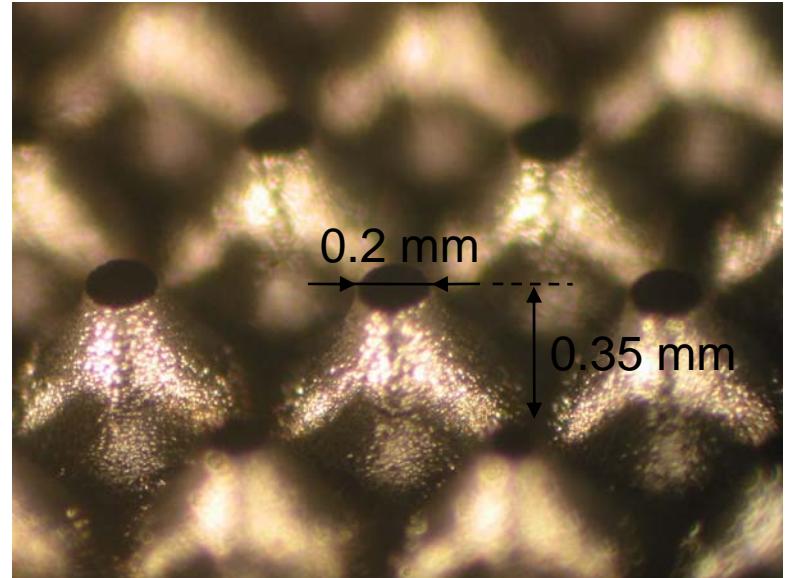
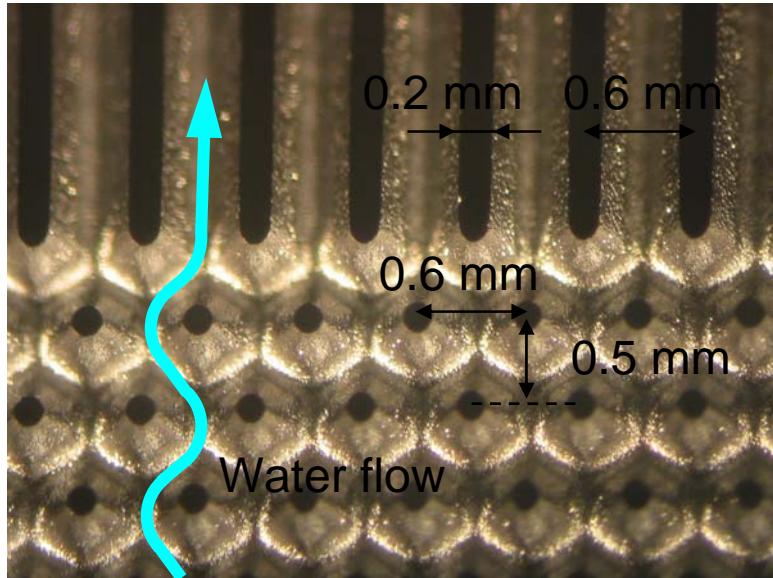
Applied to undulator beamline

Structure of pin-post crystal

Top plate with pin-post is bonded to base plate (manifold) using Au-Si eutectic bonding.



Pin-post structure



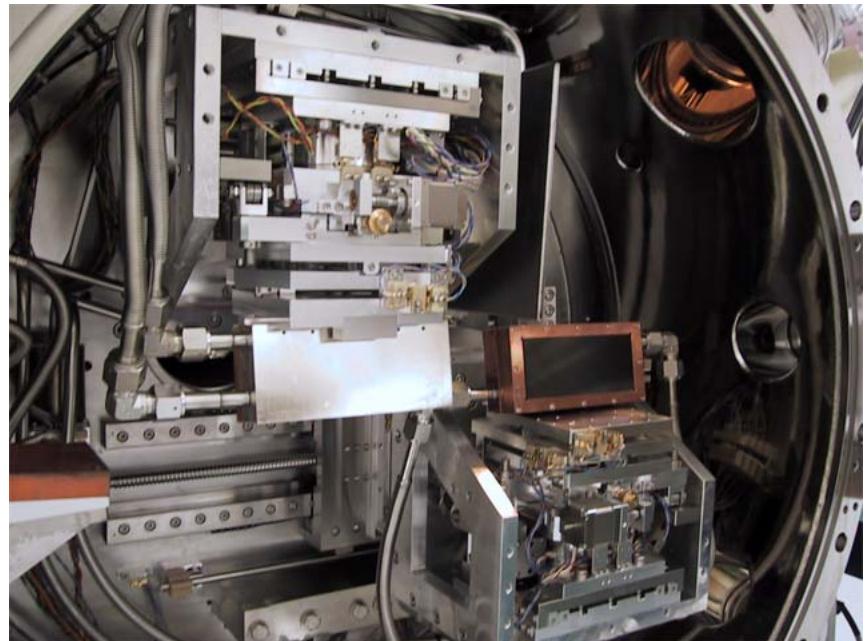
Fine pins are fabricated to increase cooling efficiency.

Limitation of sandblast

DCM with pin-post crystal

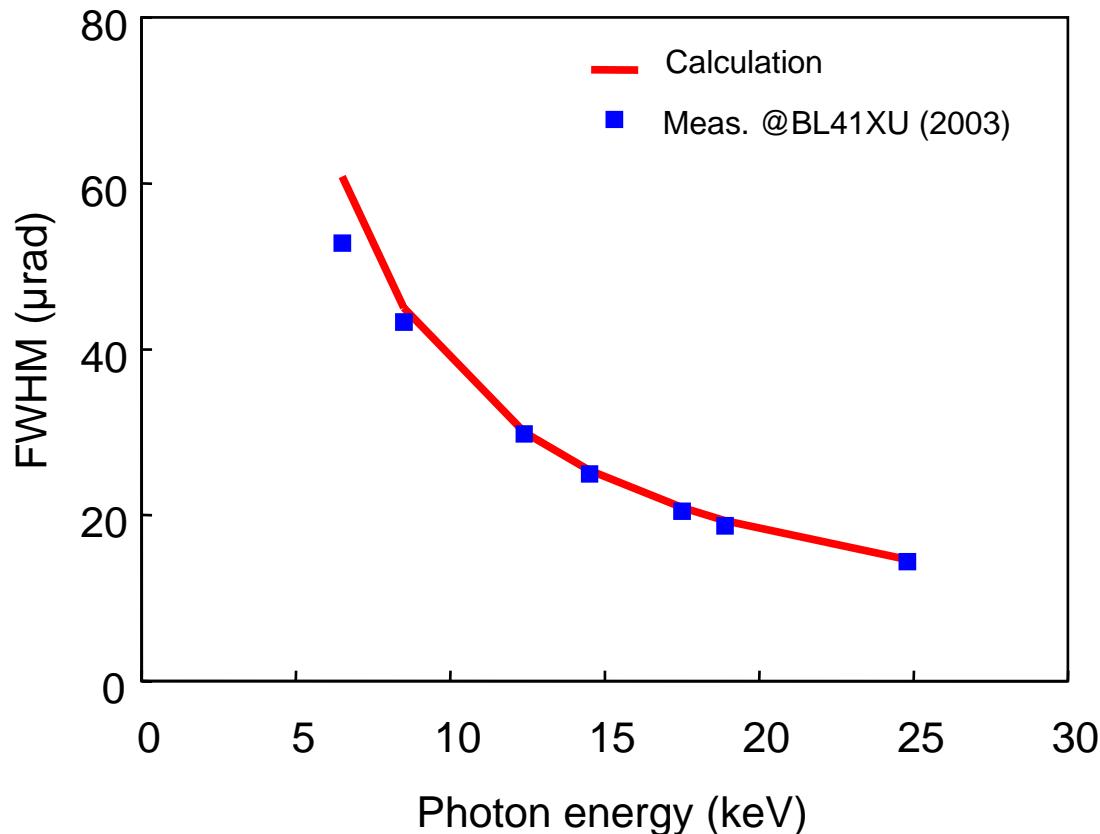


DCM view from upstream



Inside DCM: Stages + pin-post crystal

Performance of pin-post crystal



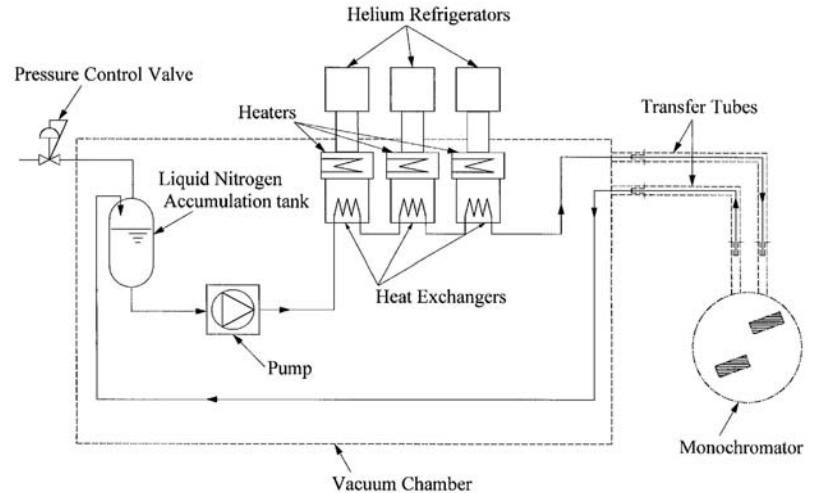
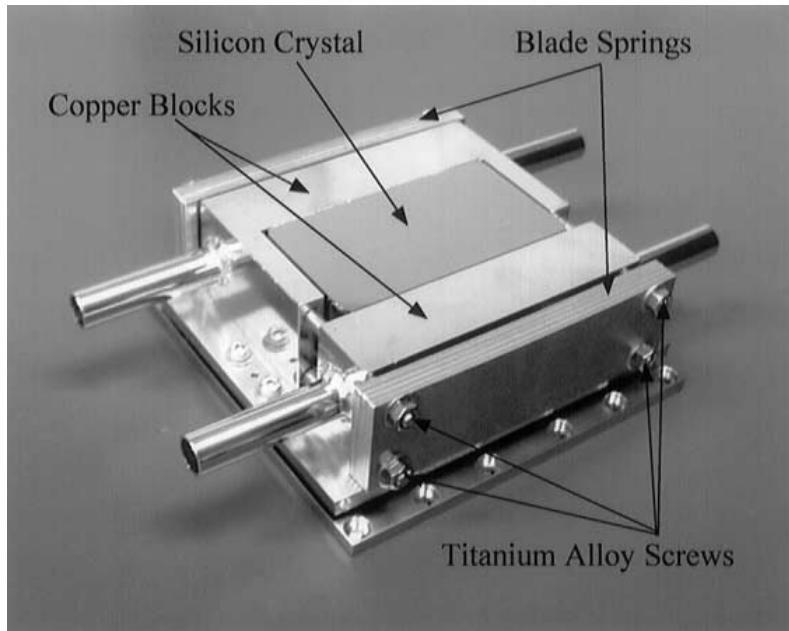
Rocking curve widths agree well.

A rocking curve is obtained by rocking (rotating) the second crystal of the double crystal arrangement and recording the diffracted intensity.

Cryogenic cooling

LN_2 circulator with He refrigerator

Indirect side cooling



Applied to undulator beamline

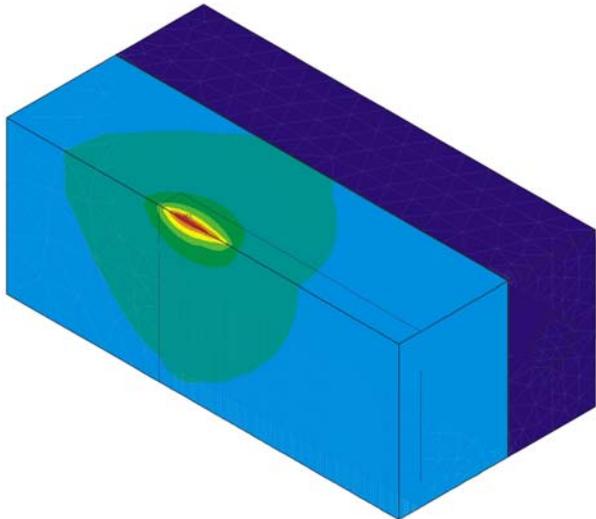
Silicon, Liquid Nitrogen Cooling

465W, $\theta=6.9^\circ$ 25 W/mm²

Spring-8 undulator beamline

Temperature distribution

BL29XU LN2 cooled Si Crystal Thermal Analysis



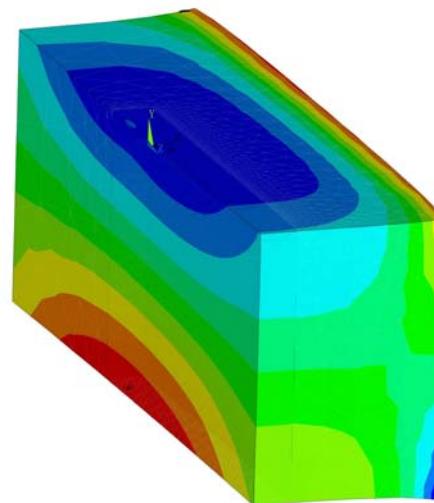
```
TIME=1  
TEMP      (AVG)  
RSYS=0  
PowerGraphics  
EFACET=1  
AVRES=Mat  
SMN =81.895  
SMX =134.189
```

PRECISE HIDDEN
81.895
87.705
93.516
99.326
105.137
110.947
116.758
122.568
128.379
134.189 [K]

Heat Load=465W
Heat flux = 25 W/mm²
K=2.17(gap:9.6mm)
E=8GeV
I=100mA
 $q_1=6.9^\circ$
LN2 flow rate = 7.3 L/min.
LN2 Temperature = 73 K
 $h=0.0076 \text{ W/mm}^2\text{K}/\text{mm}^2\text{K}$
 $h_{\ln}=0.0120 \text{ W/mm}^2\text{K}$

Deformation distribution

BL29XU LN2 cooled Si Crystal Deformation Analysis / Vertical direction



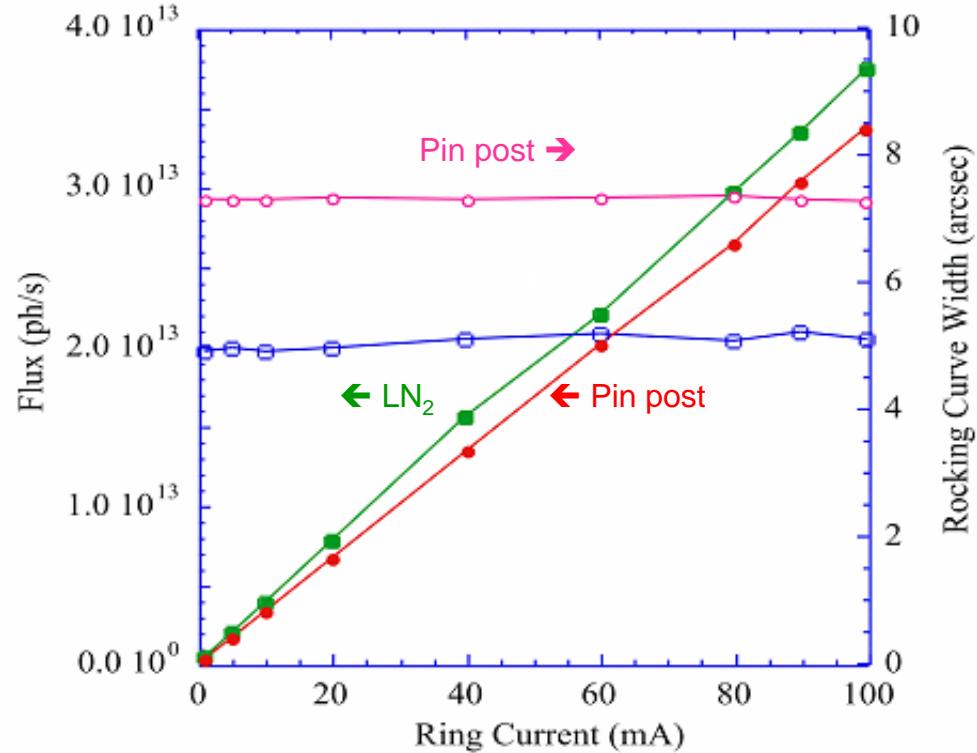
```
UY      (AVG)  
RSYS=0  
PowerGraphics  
EFACET=1  
AVRES=Mat  
DMX = .001598  
SMN = .225E-03  
SMX = .559E-03
```

PRECISE HIDDEN
.225
.262
.299
.337
.374
.411
.448
.485
.522
.559 [μm]

LN2 flow rate = 7.3 L/min.
LN2 Temperature = 73 K
Heat Load = 465 W
Heat flux = 25 W/mm²
 $h=0.0076 \text{ W/mm}^2\text{K}$

Performance of pin-post cooling and cryogenic cooling

Heat load test (June 2000) up to 500 W, 500 W/mm²



Ila diamond indirect cooling

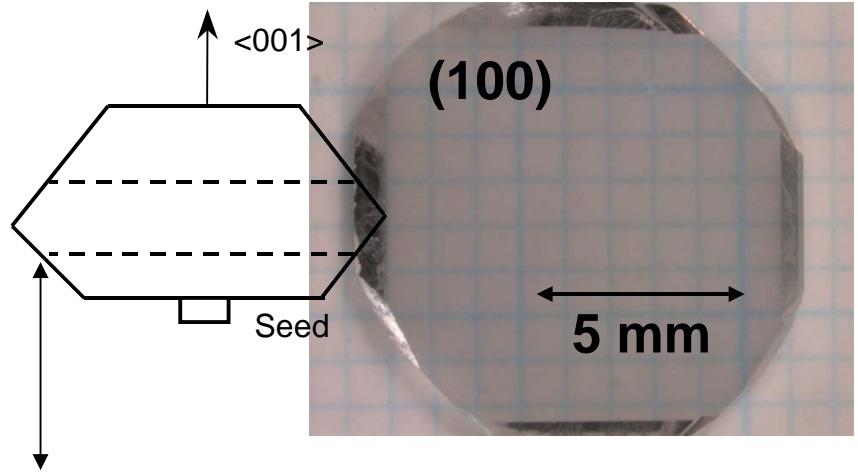
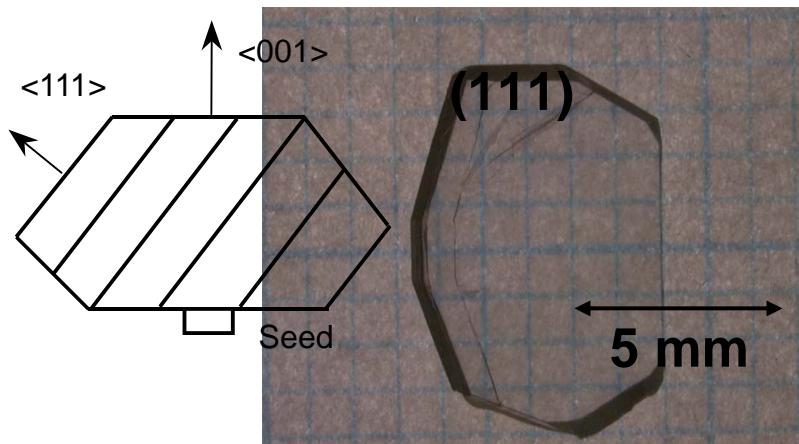
Merit:

- Good thermal properties → Capability of indirect cooling
- Higher resolution (\leftrightarrow Less throughput (30~40% of Si))

Issues:

- Perfection of crystal → HPHT Ila diamond (Sumitomo)...
Successive upgrade is crucial !
- Holding of crystal → X-ray topograph, Zygo
- Optimization of thermal contact → New process with In insert
- Small crystal (< 10 mm[□])
- Alignment: using CCD camera, PIN photodiode, thermocouple

IIa diamond crystal

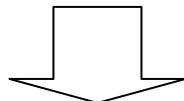


Crystal handling is crucial:
→ Mounting without strain
→ Alignment

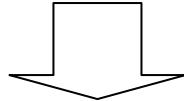
Crystal mounting

Thermal mounting method

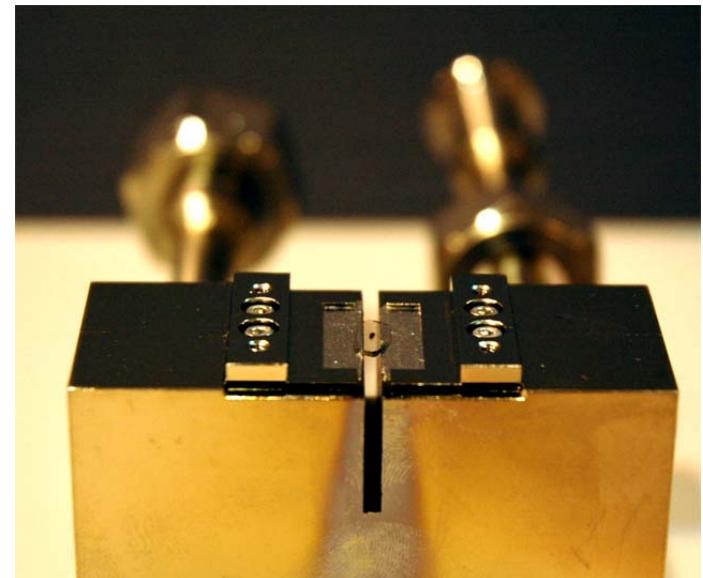
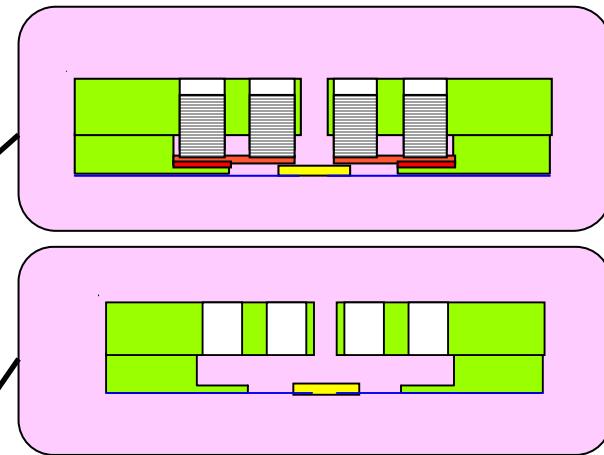
Mechanical mounting with
SS plates and screws



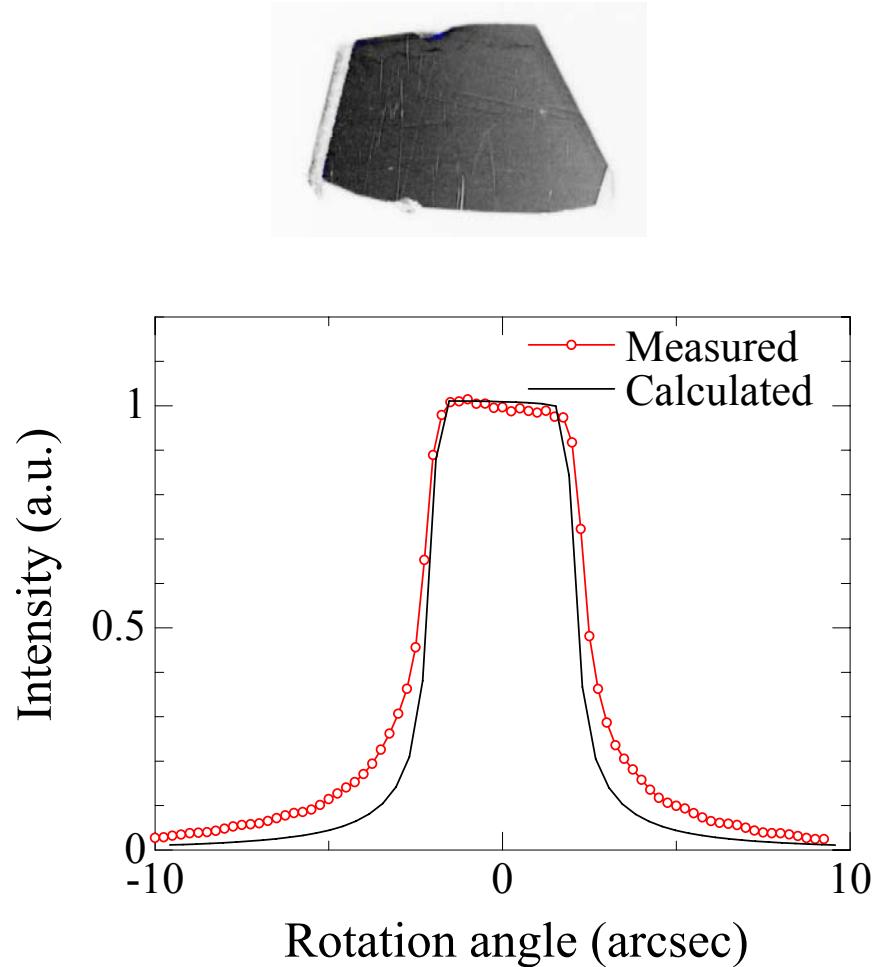
Release the screws



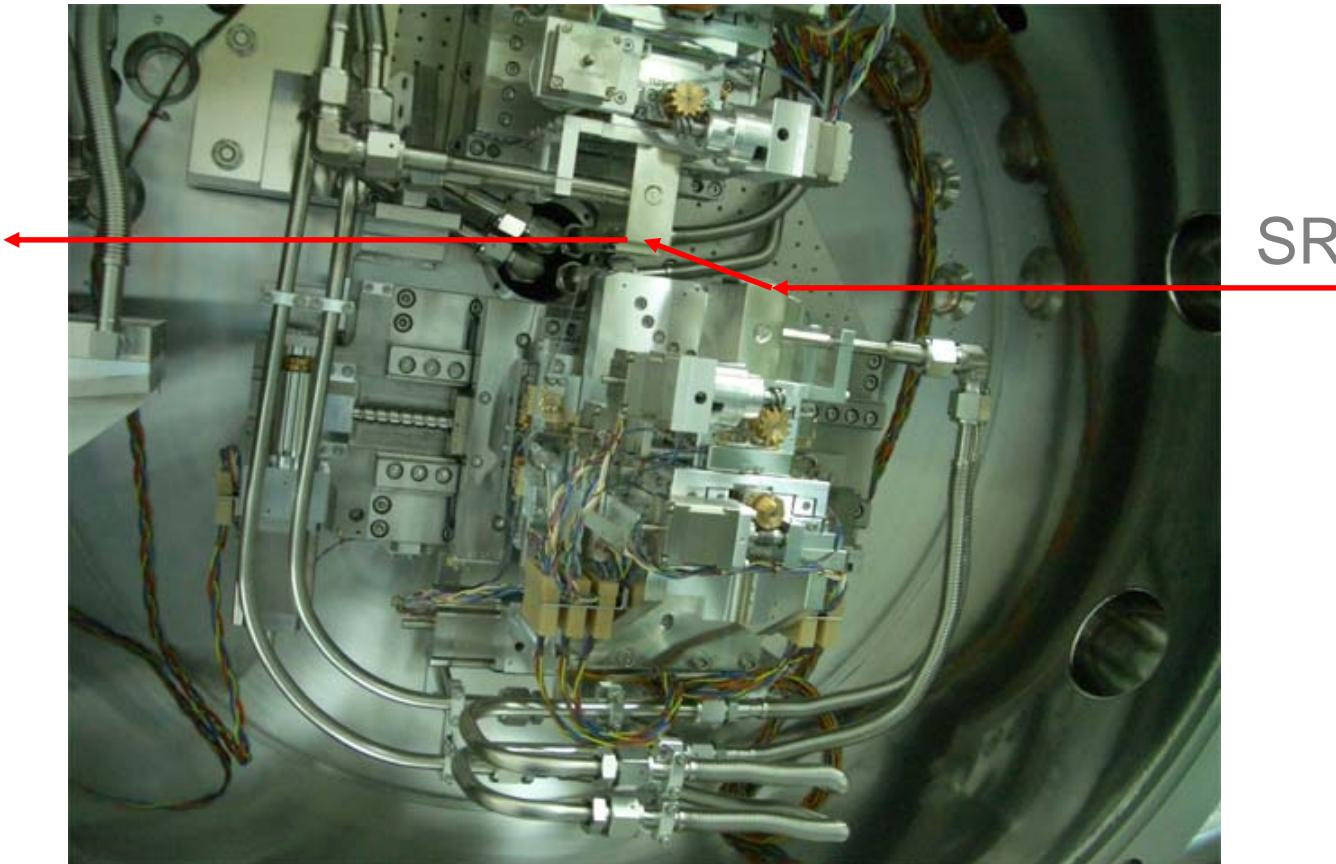
Temperature increase to $\sim 130^\circ\text{C}$
Keep 30 min
Decrease to room temperature



Topograph and rocking curve

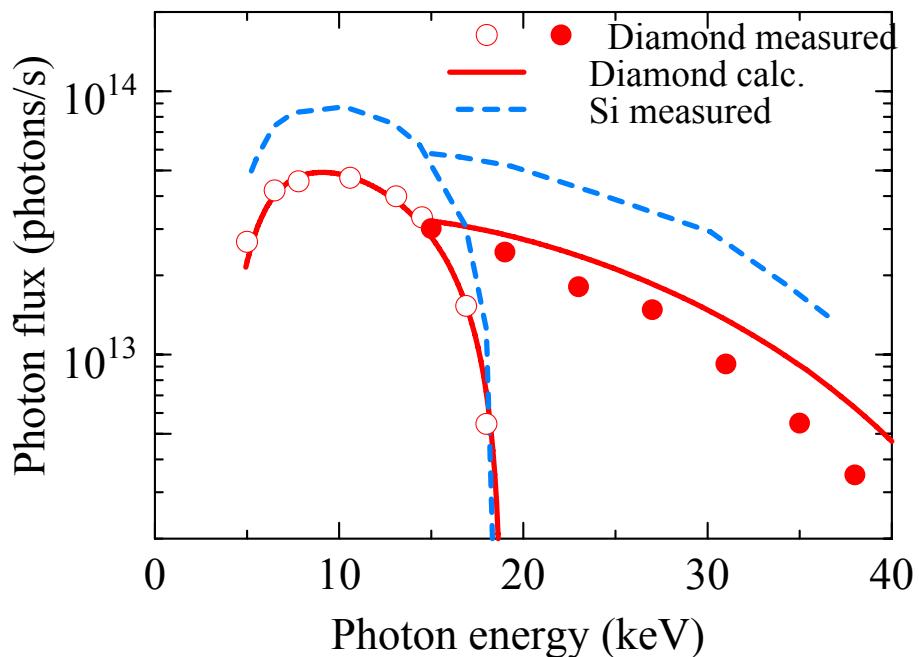


Diamond monochromator (SPring-8 BL39XU)

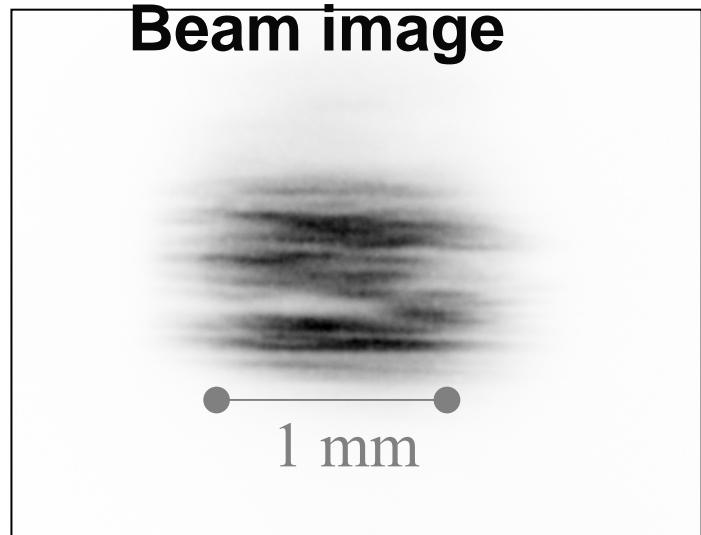


Characterization of diamond monochromator

Photon flux



Beam image



$\varepsilon = 3 \text{ nm. rad}$, $I_b = 100 \text{ mA}$
Front-end slit aperture = 0.7 (v) x 1.0 (h) mm²

Low energy: 50~60% of Si DCM
High energy: Infinite size effect ?

Improvement of crystal growth
and surface finish is needed.

Higher harmonics rejection - total reflection mirror -

□ Substrate material

Si for white radiation

SiO_2 for monochromatic beam

□ Coating material

Pt, Rh, Ni,...

Depending on energy, reflectivity, absorption edges,..

□ Glancing angle

2~10 mrad (For SPring-8 X-ray beamline)

Depending on energy, reflectivity, absorption edges,..

□ Mirror length

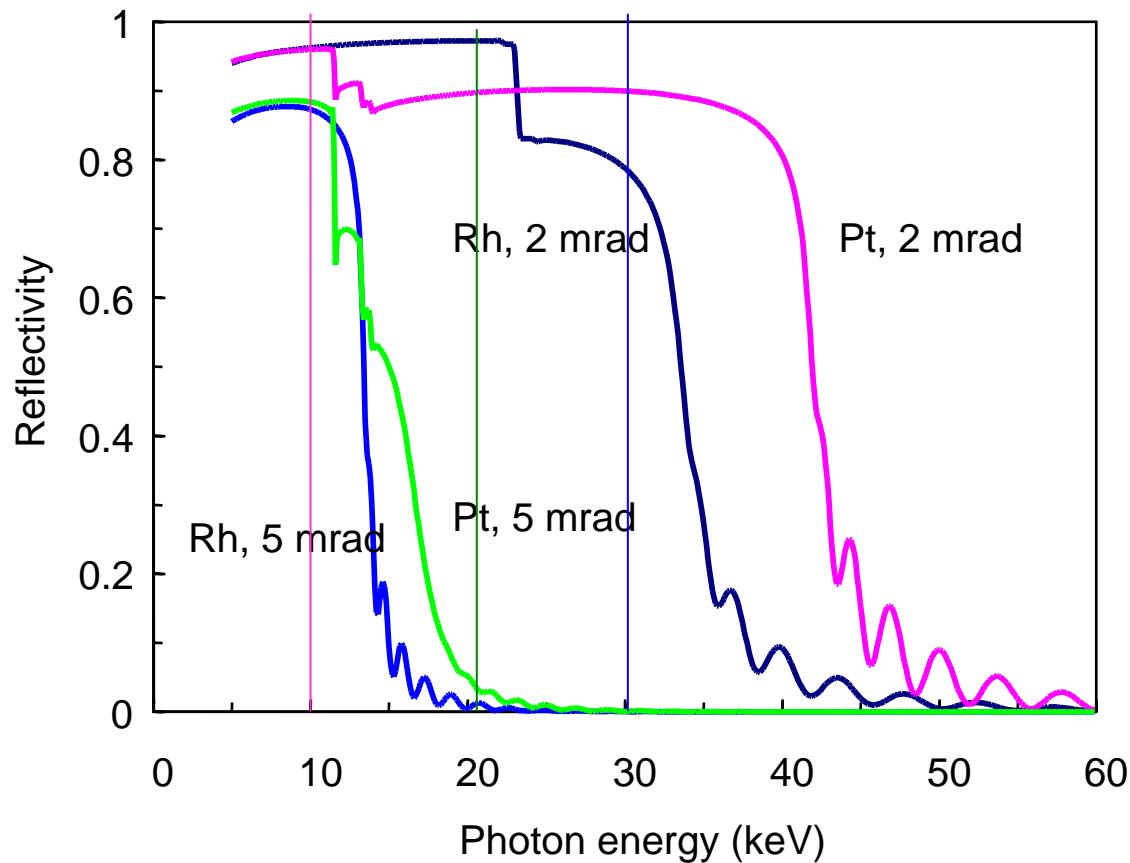
400 mm~1 m (For SPring-8 X-ray beamline)

Depending on the beam size and glancing angle

e.g. $100 \mu\text{rad} \times 50 \text{ m} / 5 \text{ mrad} = 1 \text{ m}$

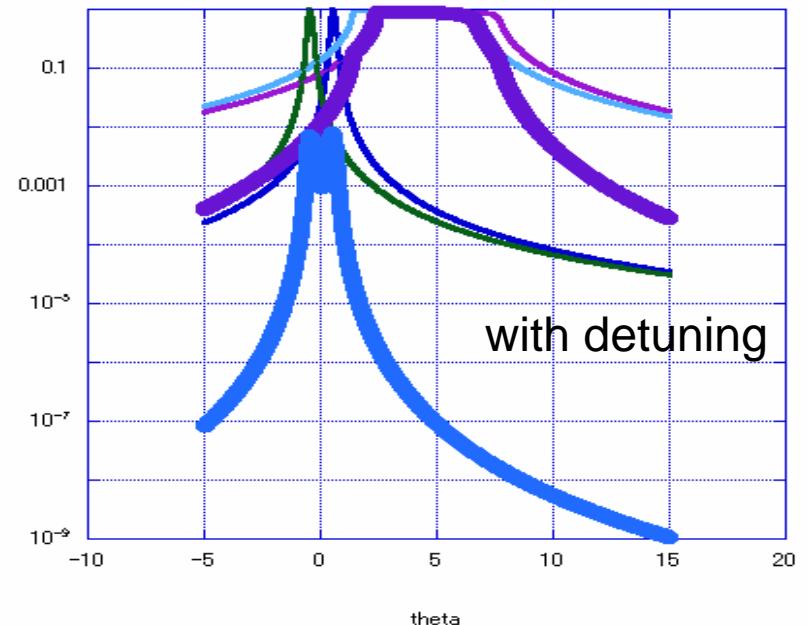
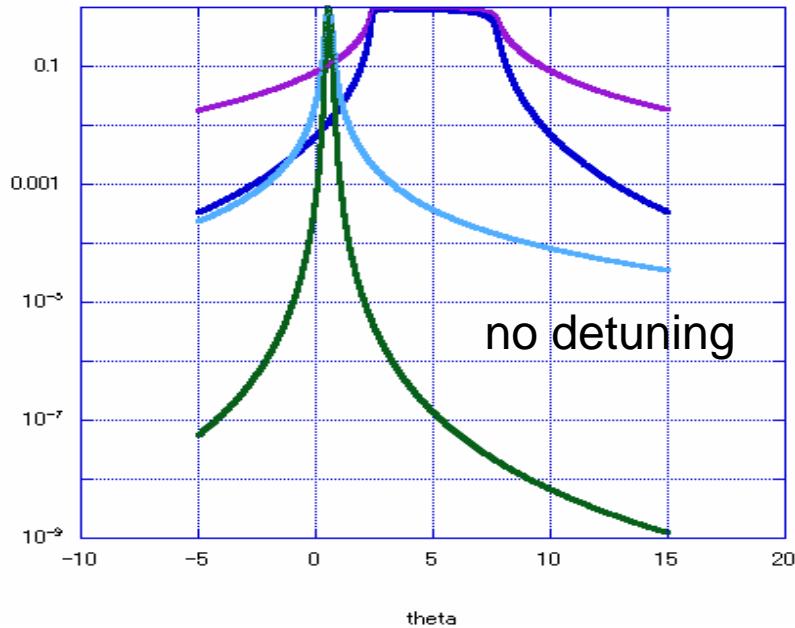


Example of mirror reflectivity



Film thickness: 50 nm
Surface roughness: 1 nm

Higher harmonics rejection - Detuning of DCM -



e.g. $\Delta\theta = 12 \mu\text{rad}$

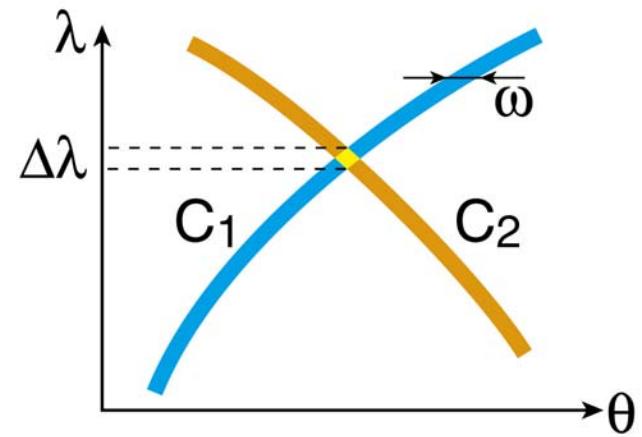
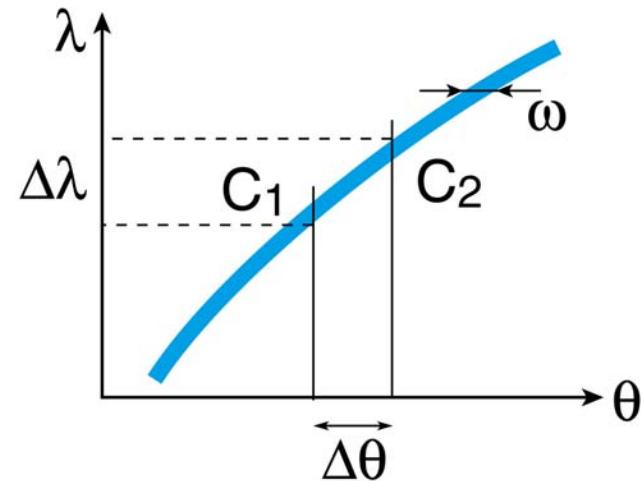
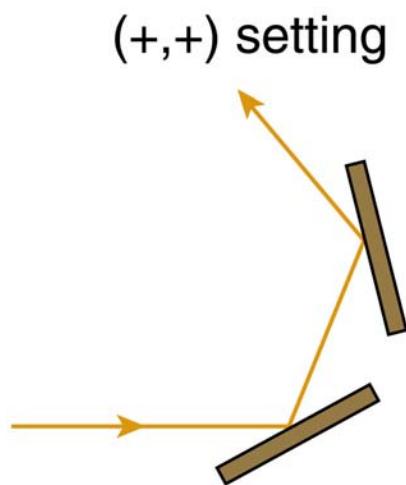
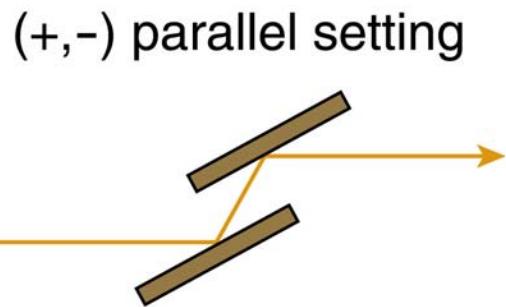
→ 70% of peak intensity for fundamental (111 refl. @ 10 keV)

→ 0.3% of peak for 3rd harmonics (333 refl. @ 30 keV)

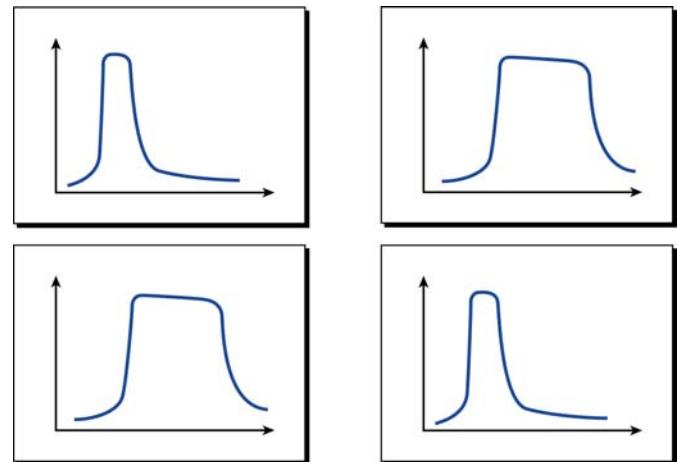
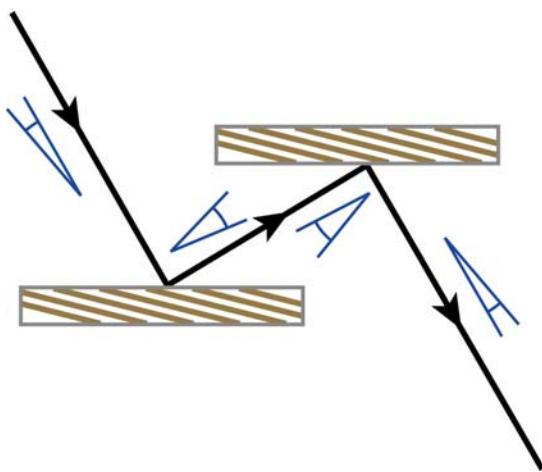
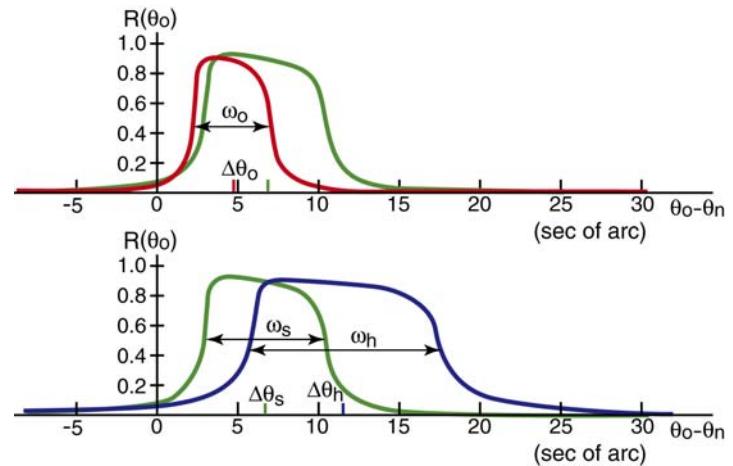
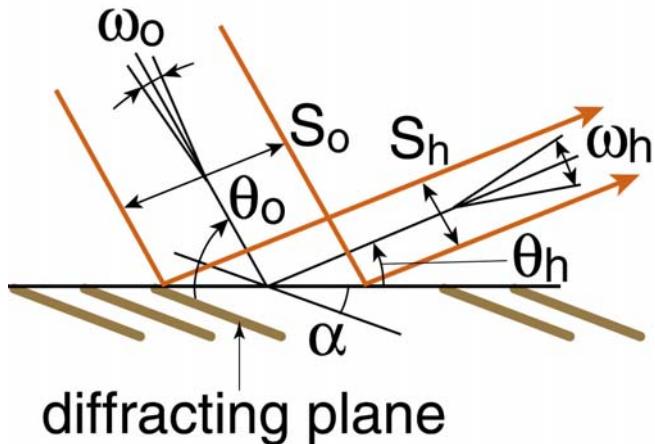
e.g. $\Delta\theta_2 = 10 \mu\text{rad} \rightarrow$ Angle change of exit beam = $2\Delta\theta_2 = 20 \mu\text{rad}$
Beam position change of 0.2 mm @ 10 m from DCM.
We should recognize the beam position change by DCM detuning!

High resolution monochromator

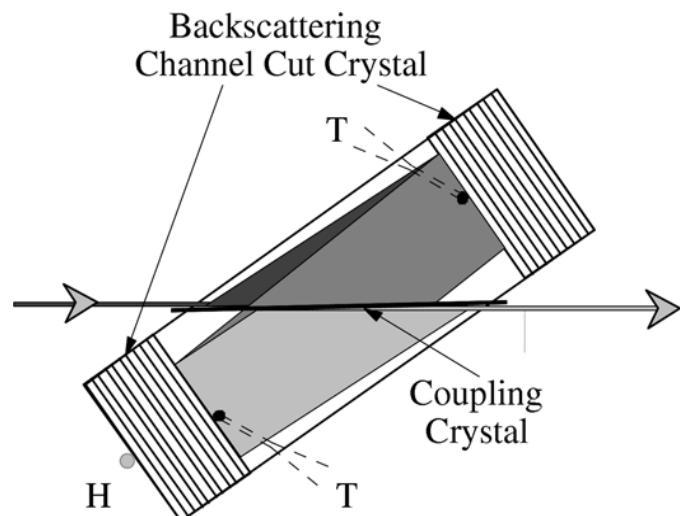
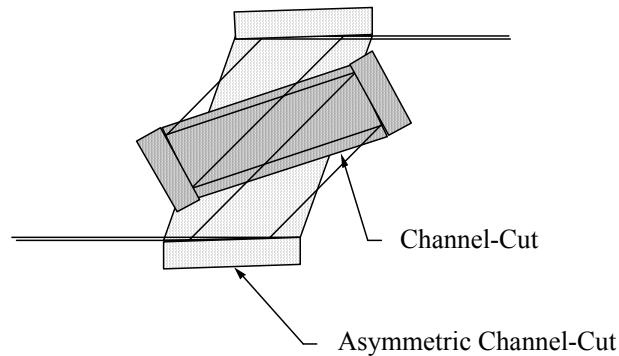
double crystal arrangements and the DuMond diagram



Asymmetric diffraction for high resolution monochromator



Extremely High-Resolution X-Ray Monochromators



Alfred Q. R. Baron,^{a*} Yoshikazu Tanaka,^b Daisuke Ishikawa,^b Daigo Miwa,^b Makina Yabashia and Tetsuya Ishikawa,^{a,b} J. Synchrotron Rad. (2001). 8, 1127-1130

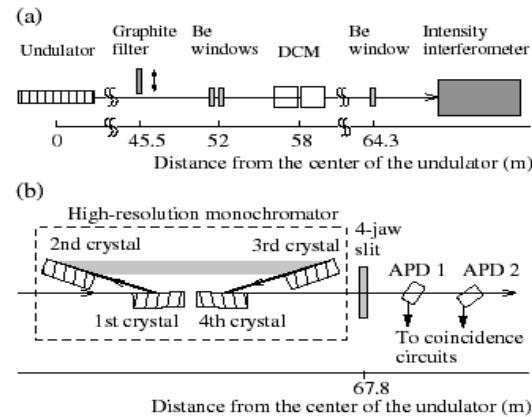
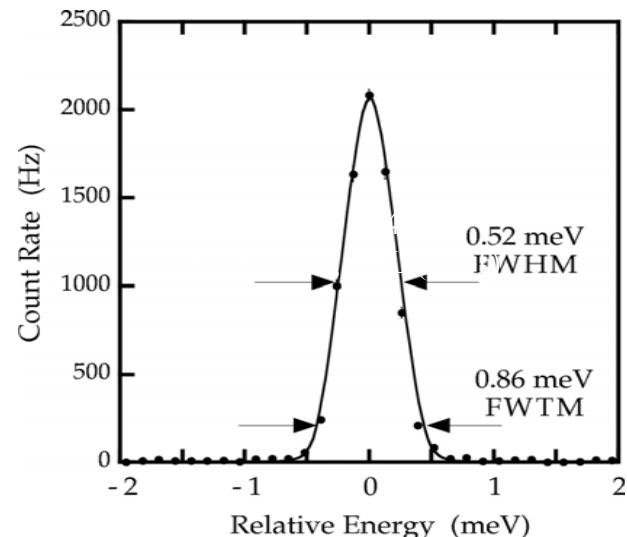
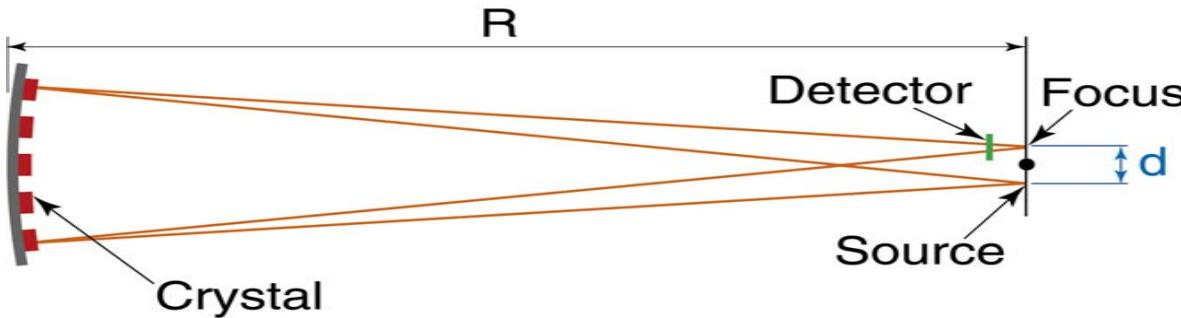


FIG. 1. Schematic top view of the experimental setup (a), and that of the intensity interferometer (b). The interferometer consists of a high-resolution monochromator using four separated crystals, a precision four-jaw slit, two semitransparent avalanche photodiodes (APDs), and coincidence circuits.



Spherical Diced Crystal Energy Analyzer

- meV resolution -



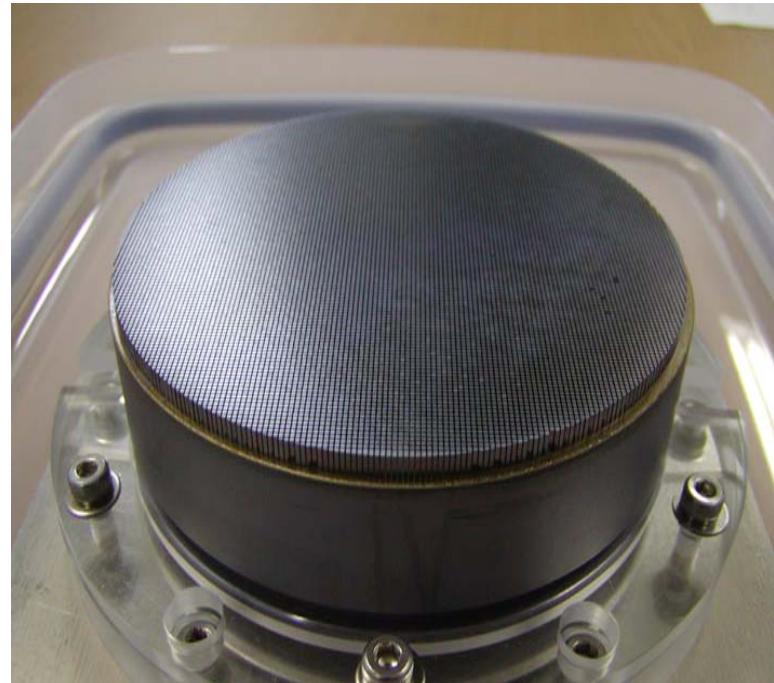
$$\frac{\Delta E}{E} = \sqrt{\omega^2 + \Delta\theta^2} \cot\theta$$

When $\theta = 89.97^\circ$

$$\cot\theta \sim 5.2 \times 10^{-4}$$

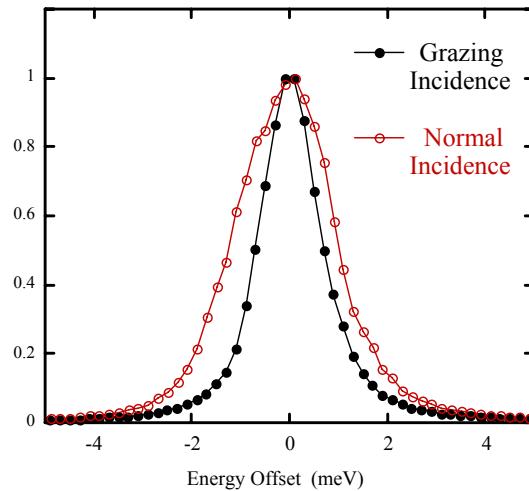
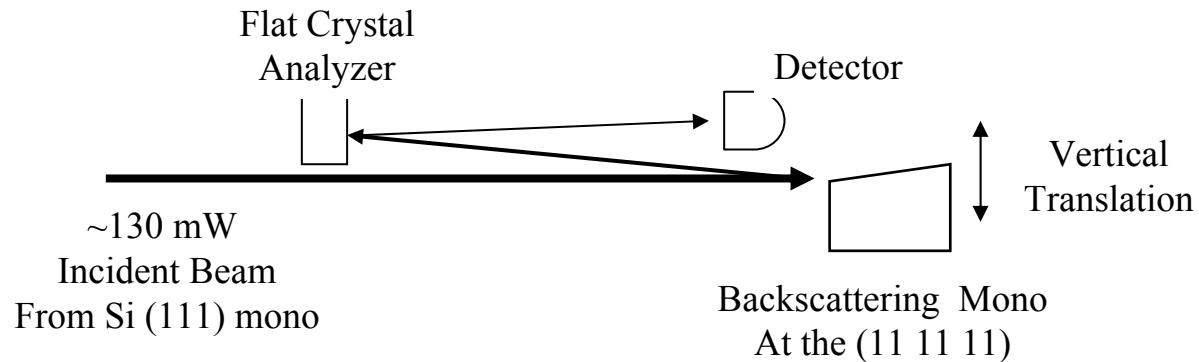
$$\text{If } \sqrt{\omega^2 + \Delta\theta^2} \sim 10^{-3} - 10^{-4}$$

$$\Delta E/E \sim 10^{-7} - 10^{-8}$$

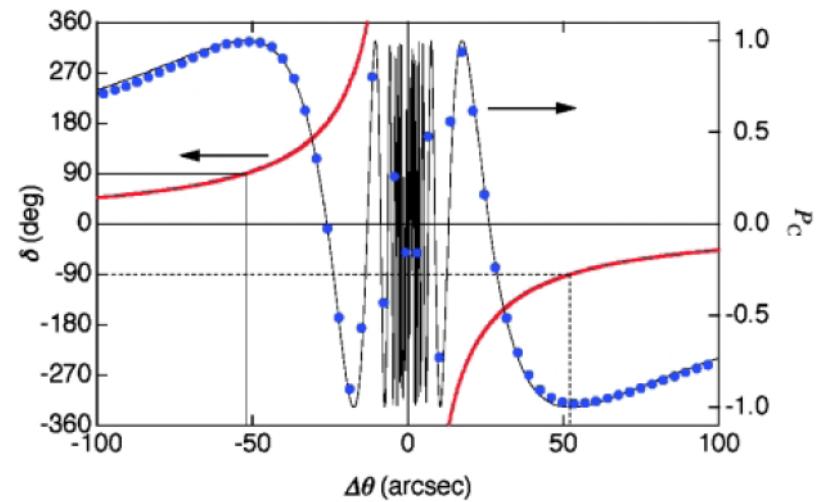
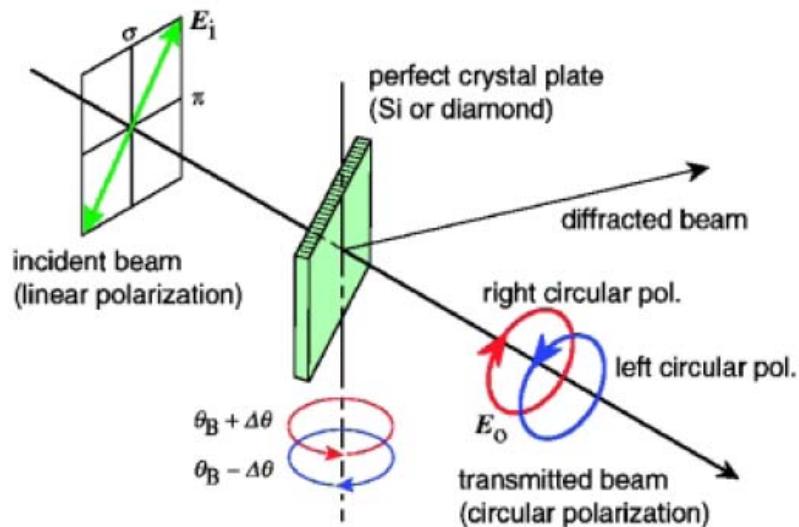


$R=9.8\text{ m}$ Spherical Diced Crystal Analyzer

Power Load Effects on Backscattering Monochromator



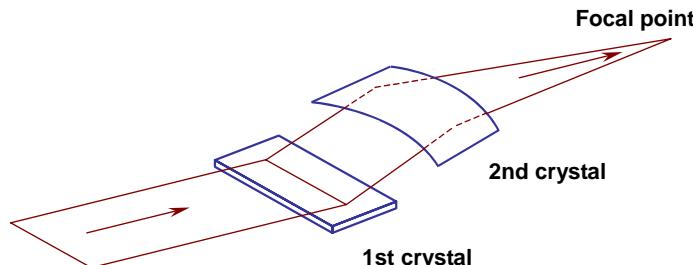
phase retarder, polarization conversion - transmission through a thin crystal -



Concept of dispersion surfaces should be utilized to understand.

Sagittal focusing

Principle of sagittal focusing



$$r = \frac{2pq}{p+q} \sin \theta$$

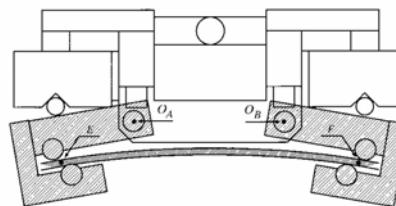
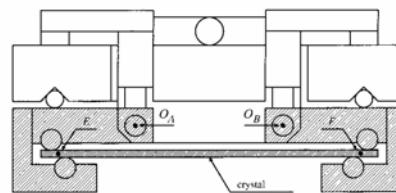
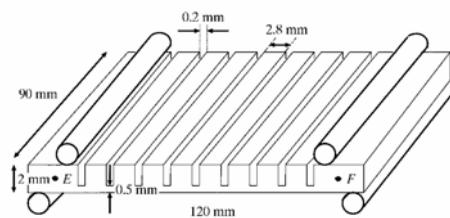
r : radius of 2nd crystal

θ : Bragg angle

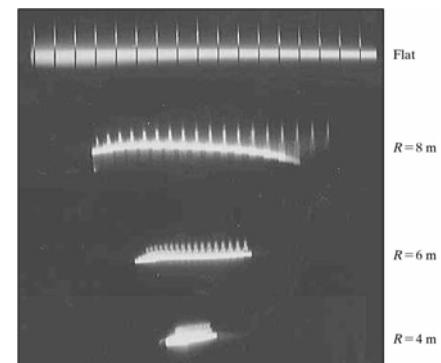
p : source ~ crystal distance

q : crystal ~ focal point distance

Bending mechanism for SPring-8 sagittal focusing



e.g. Sagittal focusing images



50 mm
Si 311 refl.

40 keV

Source~Crystal= 36.5 m

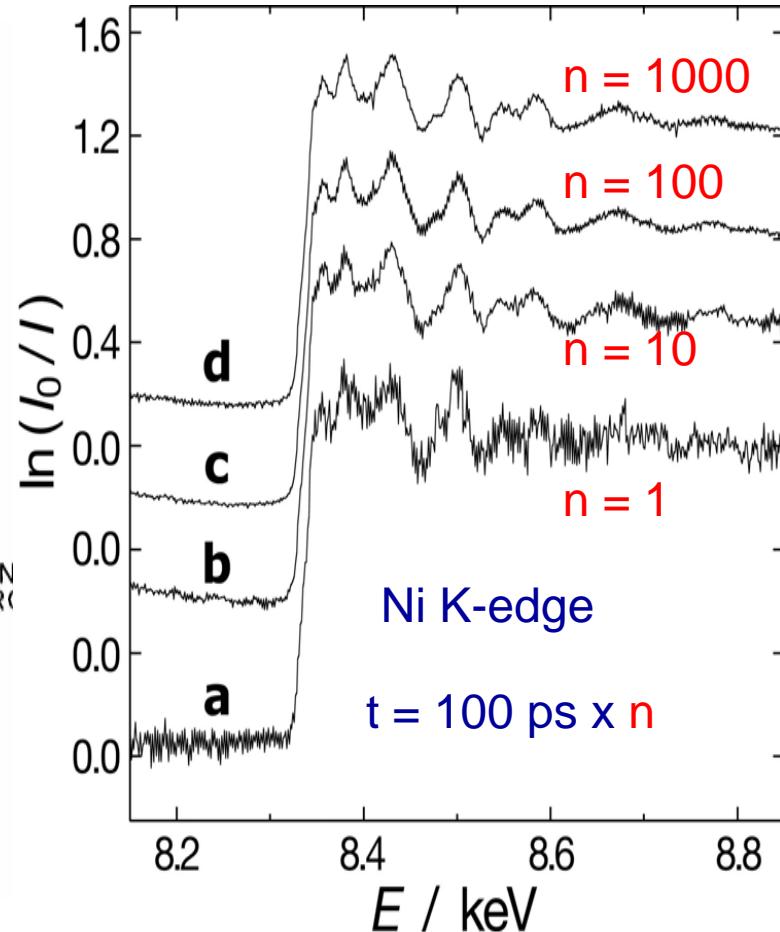
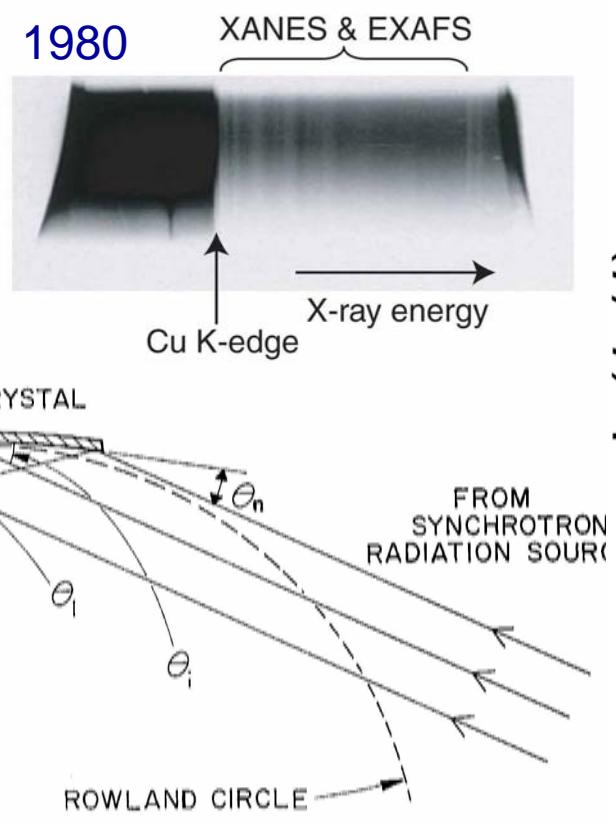
Crystal~focal point= 16.5 m

Applied for bending magnet beamline

Dispersive X-ray Absorption Spectroscopy

T. Matsushita & R. P. Phizackerley:
Jpn. J. Appl. Phys. 20, 2223-2228 (1981)

$R = 100\sim300 \text{ cm}$
 $E_H - E_L = \sim 1 \text{ keV}$



稻田、丹羽、野村:放射光、20,
242 (2007)

Multiwavelength Dispersive X-Ray Reflectometry

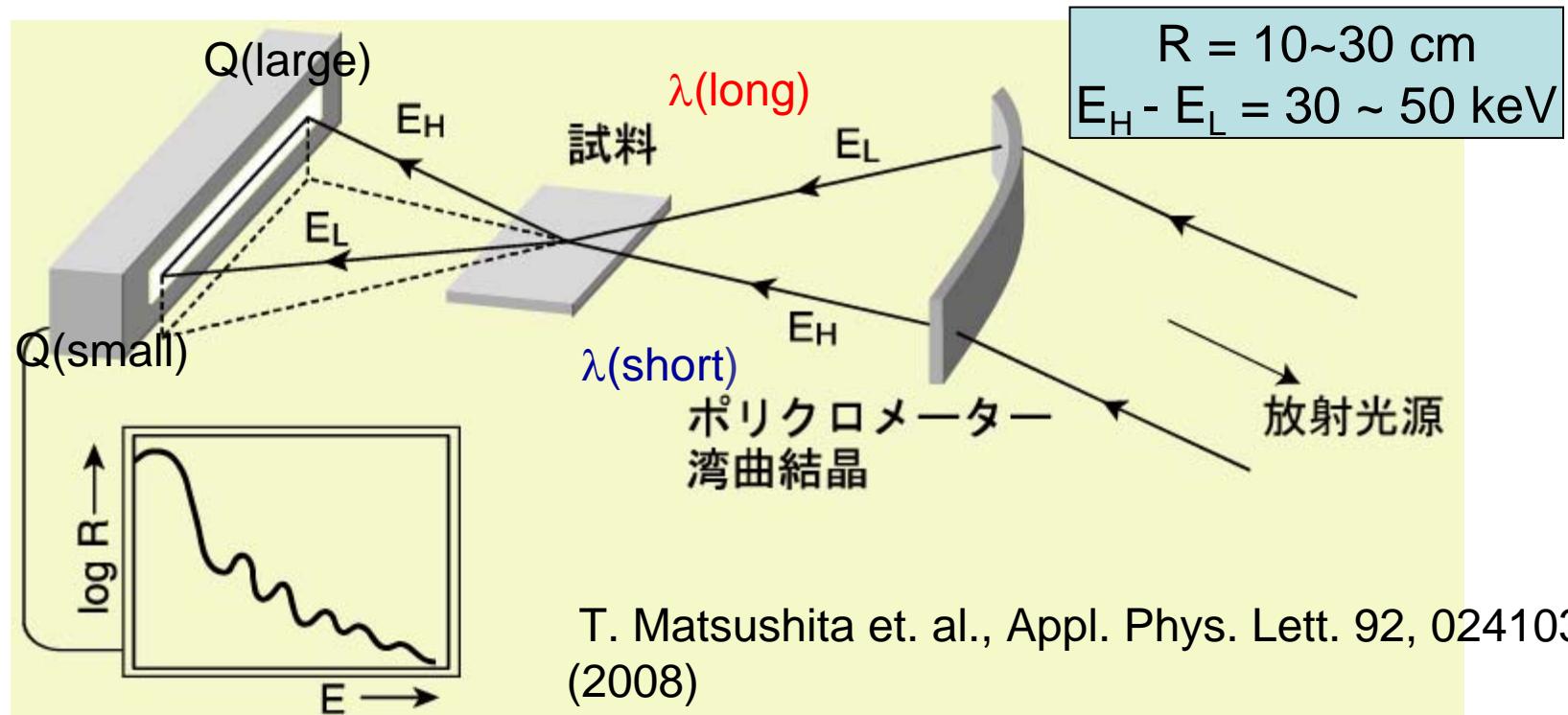
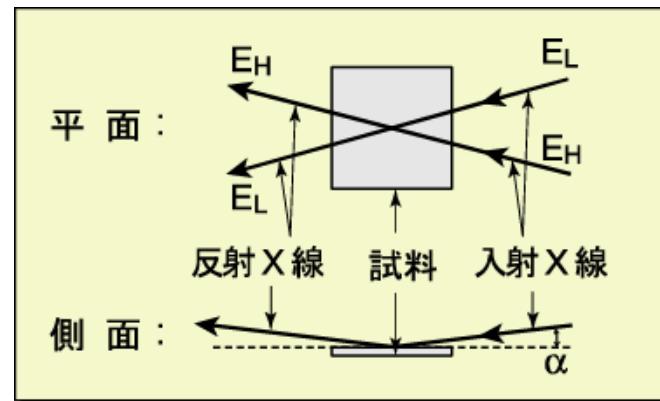
$$Q = 4\pi \sin(\alpha)/\lambda$$

$$\sim E \sin(\alpha)$$

$$Q: 0.08 \sim 0.8 \text{ \AA}^{-1}$$

$$Q_{\max}/Q_{\min} = 10$$

$$E_{\max}/E_{\min} = 10$$



T. Matsushita et. al., Appl. Phys. Lett. 92, 024103
(2008)

Other issues

- Phase space analysis
 - position-angle (position-momentum) space
- Extended Phase space
 - position-angle-wavelength space
 - position-angle-energy space
- Ray tracing
- Feedback control of the DCM
- Compton scattering (heating of the 2nd crystal)
- Stress due to crystal mounting
- Surface finish and residual stress layer
- Wide band-pass monochromators
- Quick-scan monochromators
- Dispersion surface

Future subjects

- Smaller slope error, smaller roughness, smaller residual stress
 - optics for handling more coherent X-rays
 - More higher resolution
 - Wide bandpass crystal monochromator
-
- optics for handling more bright(intense) beam
 - optics for handling extremely short pulses

Acknowledgements

Dr. S. Goto, Spring-8

Dr. T. Ishikawa, RIKEN/Spring-8

Dr. K. Hirano, Photon Factory

Prof. H. Winick, SSRL

Mr. H. Kohzu, Kohzu Seiki Co. Ltd

Mr. Koizumi , Sharan Instruments Co. Ltd

Dr. T. Mochizuki, Spring-8

Dr. M. Takata, RIKEN/Spring-8

Prof. Y. Amemiya, Univ. of Tokyo

Dr. M. Suzuki, Spring-8

Dr. T. Hirono, Spring-8